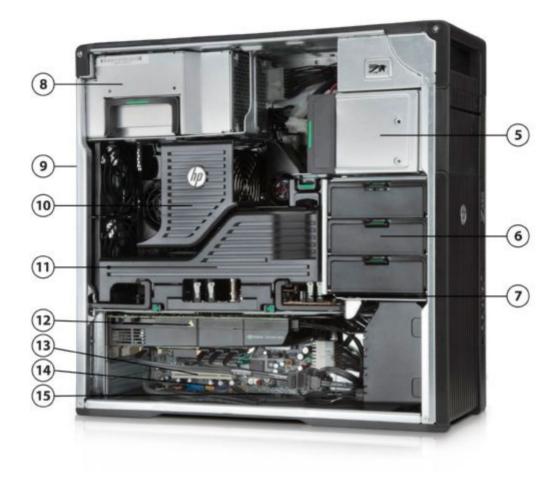
Overview



- 1. 2 External 5.25" Bays (shown with optional slot-load optical drive)
- 2. Power Button
- 3. HDD Activity LED
- 4. Front I/O: 1 USB 2.0, 2 USB 3.0, 1 Headphone, 1 Microphone, 1 1394a



Overview



- 5. 2 External 5.25" Bays
- 6. 3 Internal 3.5" Bays
- 7. 12 DIMM Slots for DDR3 ECC Memory
- 8. 800W, 90% Efficient Power Supply
- 9. Rear I/O: Rear Power Button & LED, PS/2 Ports, 1 1394a, 4 USB 2.0, 2 USB 3.0, 2 RJ-45 to Integrated GbE, 1 Audio Line In, 1 Audio Line Out, 1 Microphone
- 10. Intel Xeon Processors E5-1600 family or E5-2600 family

- 11. 2nd CPU & Memory Module
- 12. 2 PCIe x16 Gen3 Slots
- 13. 1 PCIe x8 Gen3, 1 PCIe x8(x4) Gen2, 1 PCIe x4(x1) Gen2, 1 PCI Slot
- 14. 6 Internal USB 2.0 Ports
- 15. 10 SATA Ports

Form Factor	Minitower
Operating Systems	Preinstalled:
	 Windows 7 Ultimate 64-bit* Windows 7 Professional 64-bit* Windows 7 Professional 32-bit* Windows 8.1 Pro 64-bit Windows 8.1 Simplified Chinese Edition 64-bit Windows 8.1 Pro Downgrade to Windows 7 Professional 32-bit Windows 8.1 Pro Downgrade to Windows 7 Professional 64-bit HP Installer Kit for Linux (includes drivers for 64-bit OS versions of RHEL 5 & 6 and SUSE
(p)	• DA - 14262 Worldwide QuickSpecs — Version 40 — 5.1.2014 Page 2

Overview									
 Linux Enterprise Desktop 11) Red Hat Enterprise Linux Desktop (Preinstall NOT available; 1 year paper license only) 									
					x Desklop (Fit		avaliable, 1 year	paper license or	iiy)
	S	Supported	d:						
	Genuine Windows® 7 Enterprise 32/64								
 SUSE Linux Enterprise Desktop 11 									
 Windows® XP Professional 32/64 (on select configurations)* 									
Notes: *See the "Windows XP Support Matrix for Z Workstations" at: http://www.hp.com/support/workstation_manuals									
							1.1		
					are support info ux_hardware_u		Linux, see:		
Available Proces	1		w.mp.com	/Support/line		Παιτιλ			
Name	Cores	Clock Speed	Cache	Memory Speed	QPI Speed	Hyper-	Featuring Intel vPro™	Intel® Turbo Boost	TDP
		(GHz)	(MB)	(MHz)	(GT/s)	Threading	Technology	Technology ¹	(W)
Intel Xeon E5-2643	4	3.3	10	1600	8.0	Y	Y	1, 2	130
processor									
Intel Xeon			45	4000	7.0	v	X		0.5
E5-2620	6	2.0	15	1333	7.2	Y	Y	3, 5	95
processor Intel Xeon									
E5-2697 v2	12	2.7	30	1866	8.0	Y	Y	3, 8	130
processor	12	2.1			0.0			0,0	100
Intel Xeon	1								
E5-2695 v2	12	2.4	30	1866	8.0	Y	Y	4, 8	115
processor				<u> </u>					
Intel Xeon									
E5-2690 v2	10	3.0	25	1866	8.0	Y	Y	3, 6	130
processor						ļ			
Intel Xeon	10		25	4000		v	v	2.0	
E5-2680 v2 processor	10	2.8	25	1866	8.0	Y	Y	3, 8	115
Intel Xeon									
E5-2670 v2	10	2.5	25	1866	8.0	Y	Y	4, 8	115
processor			_					, -	-
Intel Xeon								ĺ	
E5-2667 v2	8	3.3	25	1866	8.0	Y	Y	3, 7	130
processor		ļ		ļ		ļ		ļļ	
Intel Xeon				4000					~-
E5-2660 v2	10	2.2	25	1866	8.0	Y	Y	4, 8	95
processor									
Intel Xeon E5-2650 v2	8	2.6	20	1866	8.0	Y	Y	4, 8	95
processor		2.0	20	1000	0.0	'		, v	55
Intel Xeon	1	ii				ii			
E5-2643 v2	6	3.5	25	1866	8.0	Y	Y	1, 3	130
processor									
Intel Xeon E5-2640 v2	8	2.0	20	1600	7.2	Y	Y	3, 5	95
processor									

Overview

4	3.5	15	1866	8.0	Y	Y	1, 3	130
6	26	15	1600	72	Y Y	Y Y	3.5	80
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6	2.1	15	1600	1.2	l t	l t	3, 5	80
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4	2.5	10	1333	6.4	N	Y	N/A	80
4	1.8	10	1333	6.4	N	Y Y	N/A	80
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			i					1
6	2.2	15	1600		v	v	26	130
0	3.3	15	1000	-		I	3, 0	130
							ļ	
-								
6	3.2	12	1600	-	Y	Y	3, 6	130
				ļ	ļ	L	ļ	<u> </u>
4	3.6	10	1600	-	Y	Y	2, 3	130
	·		i	i	i		ĺ	i – – –
4	3.0	10	1066	_	N	v	N/A	130
-	5.0	10	1000	-		I		130
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_								
4	2.8	10	1066	-	N	Y	N/A	130
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8	3.0	25	1866	-	Y	Y	4, 9	130
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6	37	15	1866		V V	Y Y	23	130
•	0.7	10	1000	-	· ·		2, 5	
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6	3.5	12	1866	-	Y Y	Y Y	1, 4	130
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4	3.7	10	1866	-	Y	Y	0, 2	130
4	3.0	10	1600	-	N	Y Y	Ν/Δ	130
•								
ļ ļ	The state	- 161 41	l	l Isla activit		allanda ar 7 a U	l	
						occurs in 100MHz	increments. Pr	ocessor
t	hat do no	ot have tu	rbo functior	nality are denot	ted as N/A.			
			_					
							add a 2nd proc	cessor.
or \	When orc	lering two	processor	s, the second i	processor m	ust be the same a	as the first. Inte	
								. See:
				processor_inu		Cano		
	-					E 4 0044		Page /
	6 6 4 4 6 6 4 4 4 4 4 8 6 6 4 4 4 4 5 6 6 4 4 1 6 6 7 7 7 7 7 7 7 7 7 7 7 7 7	6 2.6 6 2.1 4 2.5 4 1.8 6 3.3 6 3.2 4 3.6 4 3.6 4 3.0 4 3.10 6 3.7 6 3.7 6 3.7 6 3.7 6 3.7 6 3.7 6 3.7 6 3.7 6 3.7 6 3.5 4 3.0 7 3.0 7 3.0 7 3.7 6 3.5 7 3.0 7 3.0 9 7 9 7 9 7 9 7 9 7 9 7 9 7 9 7 9 7 9 7 <td< td=""><td>6 2.6 15 6 2.1 15 4 2.5 10 4 1.8 10 6 3.3 15 6 3.2 12 4 3.6 10 4 3.6 10 4 3.6 10 4 3.6 10 4 3.6 10 4 3.6 10 4 3.6 10 4 3.6 10 5 3.7 15 6 3.7 15 6 3.7 15 6 3.7 10 4 3.0 10 4 3.7 10 4 3.0 10 4 3.0 10 5 12 10 6 3.7 10 7 10 10 8 3.0 10 9 The specifications one core maximum that do not have tupor 10</td><td>6 2.6 15 1600 6 2.1 15 1600 4 2.5 10 1333 4 1.8 10 1333 6 3.3 15 1600 6 3.2 12 1600 4 3.6 10 1600 4 3.6 10 1600 4 3.6 10 1600 4 3.6 10 1600 4 3.6 10 1600 4 3.6 10 1666 4 3.7 10 1866 6 3.7 15 1866 6 3.5 12 1866 6 3.7 10 1866 4 3.0 10 1600 4 3.7 10 1866 4 3.0 10 1600 1 The specifications shown in toone core maximum turbo step that do not have turbo step that do not have turbo step that do not have turbo step that do not have turbo step that do not have turbo step that do not have turbo step that</td><td>Image: Constraint of the second processors, the second processors, the second processor of the second p</td><td>6 2.6 15 1600 7.2 Y 6 2.1 15 1600 7.2 Y 4 2.5 10 1333 6.4 N 4 1.8 10 1333 6.4 N 6 3.3 15 1600 - Y 6 3.2 12 1600 - Y 4 3.6 10 1600 - Y 4 3.6 10 1600 - Y 4 3.6 10 1660 - N 4 3.6 10 1066 - N 4 3.0 10 1066 - N 6 3.7 15 1866 - Y 4 3.7 10 1866 - Y 4 3.7 10 1600 - N 1 The specifications shown in this column represent</td><td>6 2.6 15 1600 7.2 Y Y 6 2.1 15 1600 7.2 Y Y 4 2.5 10 1333 6.4 N Y 4 1.8 10 1333 6.4 N Y 6 3.3 15 1600 - Y Y 6 3.2 12 1600 - Y Y 6 3.2 12 1600 - Y Y 4 3.6 10 1660 - N Y 4 3.6 10 1066 - N Y 4 3.0 25 1866 - Y Y 6 3.7 15 1866 - Y Y 4 3.0 10 1600 - N Y 4 3.7 10 1866 - Y <td< td=""><td>Image: Constraint of the second sec</td></td<></td></td<>	6 2.6 15 6 2.1 15 4 2.5 10 4 1.8 10 6 3.3 15 6 3.2 12 4 3.6 10 4 3.6 10 4 3.6 10 4 3.6 10 4 3.6 10 4 3.6 10 4 3.6 10 4 3.6 10 5 3.7 15 6 3.7 15 6 3.7 15 6 3.7 10 4 3.0 10 4 3.7 10 4 3.0 10 4 3.0 10 5 12 10 6 3.7 10 7 10 10 8 3.0 10 9 The specifications one core maximum that do not have tupor 10	6 2.6 15 1600 6 2.1 15 1600 4 2.5 10 1333 4 1.8 10 1333 6 3.3 15 1600 6 3.2 12 1600 4 3.6 10 1600 4 3.6 10 1600 4 3.6 10 1600 4 3.6 10 1600 4 3.6 10 1600 4 3.6 10 1666 4 3.7 10 1866 6 3.7 15 1866 6 3.5 12 1866 6 3.7 10 1866 4 3.0 10 1600 4 3.7 10 1866 4 3.0 10 1600 1 The specifications shown in toone core maximum turbo step that do not have turbo step that do not have turbo step that do not have turbo step that do not have turbo step that do not have turbo step that do not have turbo step that	Image: Constraint of the second processors, the second processors, the second processor of the second p	6 2.6 15 1600 7.2 Y 6 2.1 15 1600 7.2 Y 4 2.5 10 1333 6.4 N 4 1.8 10 1333 6.4 N 6 3.3 15 1600 - Y 6 3.2 12 1600 - Y 4 3.6 10 1600 - Y 4 3.6 10 1600 - Y 4 3.6 10 1660 - N 4 3.6 10 1066 - N 4 3.0 10 1066 - N 6 3.7 15 1866 - Y 4 3.7 10 1866 - Y 4 3.7 10 1600 - N 1 The specifications shown in this column represent	6 2.6 15 1600 7.2 Y Y 6 2.1 15 1600 7.2 Y Y 4 2.5 10 1333 6.4 N Y 4 1.8 10 1333 6.4 N Y 6 3.3 15 1600 - Y Y 6 3.2 12 1600 - Y Y 6 3.2 12 1600 - Y Y 4 3.6 10 1660 - N Y 4 3.6 10 1066 - N Y 4 3.0 25 1866 - Y Y 6 3.7 15 1866 - Y Y 4 3.0 10 1600 - N Y 4 3.7 10 1866 - Y <td< td=""><td>Image: Constraint of the second sec</td></td<>	Image: Constraint of the second sec



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Overview	
	Multi-Core technologies are designed to improve performance of multithreaded software products and hardware-aware multitasking operating systems and may require appropriate operating system software for full benefits; check with software provider to determine suitability; Not all customers or software applications will necessarily benefit from use of these technologies.
	64-bit computing on Intel® 64 architecture requires a computer system with a processor, chipset, BIOS, operating system, device drivers, and applications enabled for Intel® 64 architecture. Processor will not operate (including 32-bit operation) without an Intel® 64 architecture-enabled BIOS. Performance will vary depending on your hardware and software configurations. See: http://www.intel.com/info/em64t for more information.
Additional Details	 Intel® Sandy Bridge Architecture Intel® C602 Chipset Intel® C602 Chipset Intel® Xeon® processor E5-2600 product family Intel® Xeon® processor E5-2600 v2 product family Intel® Xeon® processor E5-1600 product family Intel® Xeon® processor E5-1600 v2 product family Intel® Xeon® processor E5-1600 v2 product family (Sandy Bridge, Socket R) Up to 8.0GT/s QPI support with two QPI links between processors 4-channel per processor 1066/1333/1600/1866 MHz DDR3 memory* subsystem Up to 192 GB Memory capacity with 12 DIMM slots and 16 GB DIMMs (with two processors installed) PCI Express I/O and dual PCIe x16 Gen3 graphics support Dual Integrated Intel Gigabit LAN on Motherboard (LOM) 2 channels of Serial ATA (SATA) 6.0 Gb/s and 8 channels of SATA 3.0 Gb/s natively supported internally SATA RAID 0, 1, 5, and 10 support standard on motherboard SAS RAID 0, 1, and 10 supported using the LSI 9212-4i 6Gb/s controller SATA optical drives High Definition integrated audio with internal speaker 800W 90% efficient power supply ENERGY STAR® qualification and energy-saving features available on selected configurations (Not supported by Linux) Protected by HP Services, including a 3 years parts, 3 years labor, and 3 years onsite service (3/3/3) standard warranty. Terms and conditions vary by country. Certain restrictions and exclusions apply.
Form Factor	1 DIMM must be inserted into each channel. To get full 8 channel support, 2 processors MUST be installed. 4U Rackable Minitower
Color	
I/O Expansion Slots	Brushed aluminum & black Slot 1 (top): PCI Express Gen2 x4(1)* Full-height, Half-length (not available when 2nd CPU/Memory Module is installed)
	Slot 2: PCI Express Gen3 x16 Full-height, Full-length (with extender)
	Slot 3: PCI Express Gen2 x8(4)* with open-ended connector** Full-height, Full-length (with extender)
	Slot 4: PCI Express Gen3 x8 with open-ended connector** Full-height, Full-length (with extender)

Overview

Overview							
	Slot 5: PCI Express Gen3 x16 Full-height, Full-length (w	vith extender)					
	Slot 6: PCI 32bit/33MHz Full-height, Full-length (w	vith extender)					
	(number) = number of lar x(#)electrical.	<pre>x<number> = number of lanes or size of the physical/mechanical connector. number) = number of lanes supported electrically. Typically communicated as x# mechanical, #)electrical. open-ended connector allow a greater bandwidth (e.g. x16) card to be installed physically into a</number></pre>					
	lower bandwidth connect						
Mass Storage Bays (see Storage section for more details)							
Internal Bays	3 internal 3.5" bays (with	acoustic dampening rail assemblies pre-installed)					
External Bays	2 external 5.25" bays (4th HDD occupies one e	external bay)					
Front I/O	2 USB 3.0, 1 USB 2.0, 1	Headphone, 1 Microphone, 1 IEEE 1394a					
Rear I/O	1 Microphone	RJ-45 integrated Gigabit LAN, 2 PS/2, 1 Audio Line-In, 1 Audio Line-Out, ional connector on PCI bracket cabled to system board connector					
Internal USB	· ·	6 USB 2.0 ports available by three separate 2x5 headers. Each 2x5 header supports either one HP Internal USB Port Kit (EM165AA) or one 22-in-1 Media Card Reader.					
Chassis Dimensions (H	44.45 x 17.15 x 46.48 cn	n (17.5 x 6.75 x 18.3 in)					
x W x D)	Rack utilization: 4U						
System Weight	Actual weight depends u Minimum config: 15.5 kg Typical config: 17.9 kg (3 Maximum config: 22.6 kg	(34.2 lb) 9.4 lb)					
Temperature	Operating:	5° to 35° C (40° to 95° F)					
	Non-operating	-40° to 60° C (-40° to 140° F)					
Humidity	Operating:	8% to 85% relative humidity, non-condensing					
	Non-operating	8% to 90% relative humidity, non-condensing					
Maximum Altitude (non		3,048m (10,000ft)					
pressurized)	Non-operating	9,144m (30,000ft)					
Power Supply	The Power Supply Efficie	cient wide-ranging, active Power Factor Correction ency Report for this product may be found at this link: TBD					
Interfaces Supported	(2 @ 6 Gb/s, 4 @ 3 Gb/s	ce (2 @ 6.0 Gb/s and 8 @ 3.0 Gb/s). 6 channels are eSATA configurable a) for use with eSATA CTO/AMO Kit. No hot plug / hot swap supported.					
Hard Drive Controllers Supported	SATA and SAS controlle	rs					
Backup Devices		compatible DAT tape drives, LTO tape drives and RDX Removable Disk s, please visit http://www.hp.com/go/connect					
Workstation ISV Certifications	See the latest list of cert http://www.hp.com/united	ifications at d-states/campaigns/workstations/partnerships.html					

Supported Components

Processors

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
Intel Xeon E5-2600 Series - CTO				
Intel® Xeon® Processor E5-2620 6C 2.00GHz	Y	Ν		
Intel® Xeon® Processor E5-2643 4C 3.30GHz	Y	Ν		
Intel Xeon E5-1600 Series				
Intel® Xeon® Processor E5-1620 4C 3.60GHz	Y	Ν		
Intel® Xeon® Processor E5-1603 4C 2.80GHz	Y	Ν		
Intel Xeon E5-2600 Series - Z620 AMO				
Z620 Xeon E5-2620 6C 2.00 15MB 1333 CPU2	Ν	Y	A6S74AA	
Z620 Xeon E5-2643 4C 3.30 10MB 1600 CPU2	N	Y	A6S77AA	
Intel Xeon E5-2600 v2 Series - CTO				
Intel® Xeon® Processor E5-2667 v2 8C 3.30GHz	Y	Ν		
Intel® Xeon® Processor E5-2650 v2 8C 2.60GHz	Y	Ν		
Intel® Xeon® Processor E5-2643 v2 6C 3.50GHz	Y	Ν		
Intel® Xeon® Processor E5-2695 v2 12C 2.40GHz	Y	Ν		
Intel® Xeon® Processor E5-2690 v2 10C 3.00GHz	Y	Ν		
Intel® Xeon® Processor E5-2637 v2 4C 3.50GHz	Y	Ν		
Intel® Xeon® Processor E5-2620 v2 6C 2.10GHz	Y	Ν		
Intel® Xeon® Processor E5-2603 v2 4C 1.80GHz	Y	Ν		
Intel® Xeon® Processor E5-2660 v2 10C 2.20GHz	Y	Ν		
Intel® Xeon® Processor E5-2630 v2 6C 2.60GHz	Y	Ν		
Intel® Xeon® Processor E5-2609 v2 4C 2.50GHz	Y	Ν		
Intel® Xeon® Processor E5-2640 v2 8C 2.00GHz	Y	Ν		
Intel® Xeon® Processor E5-2670 v2 10C 2.50GHz	Y	Ν		
Intel® Xeon® Processor E5-2697 v2 12C 2.70GHz	Y	Ν		
Intel® Xeon® Processor E5-2680 v2 10C 2.80GHz	Y	Ν		
Intel Xeon E5-1600 v2 Series				
Intel® Xeon® Processor E5-1607 v2 4C 3.00GHz	Y	Ν		
Intel® Xeon® Processor E5-1620 v2 4C 3.70GHz	Y	Ν		
Intel® Xeon® Processor E5-1680 v2 8C 3.00GHz	Y	Ν		
Intel® Xeon® Processor E5-1660 v2 6C 3.70GHz	Y	Ν		
Intel® Xeon® Processor E5-1650 v2 6C 3.50GHz	Y	Ν		
Intel Xeon E5-2600 v2 Series - Z620 AMO				
Z620 Xeon E5-2640 v2 8C 2.00 20MB 1600 CPU2	Ν	Y	E3E09AA	
Z620 Xeon E5-2667 v2 8C 3.30 25MB 1866 CPU2	Ν	Y	E3E13AA	
Z620 Xeon E5-2630 v2 6C 2.60 15MB 1600 CPU2	Ν	Y	E3E07AA	
Z620 Xeon E5-2650 v2 8C 2.60 20MB 1866 CPU2	Ν	Y	E3E11AA	
Z620 Xeon E5-2620 v2 6C 2.10 15MB 1600 CPU2	N	Y	E3E06AA	
Z620 Xeon E5-2603 v2 4C 1.80 10MB 1333 CPU2	N	Y	E3E04AA	
Z620 Xeon E5-2690 v2 10C 3.00 25MB 1866 CPU2	N	Y	E3E16AA	
Z620 Xeon E5-2637 v2 4C 3.50 15MB 1866 CPU2	Ν	Y	E3E08AA	
Z620 Xeon E5-2697 v2 12C 2.70 30MB 1866 CPU2	Ν	Y	E3E18AA	
Z620 Xeon E5-2609 v2 4C 2.50 10MB 1333 CPU2	Ν	Y	E3E05AA	
Z620 Xeon E5-2670 v2 10C 2.50 25MB 1866 CPU2	Ν	Y	E3E14AA	



Supported Components

Z620 Xeon E5-2660 v2 10C 2.20 25MB 1866 CPU2	Ν	Y	E3E12AA
Z620 Xeon E5-2695 v2 12C 2.40 30MB 1866 CPU2	Ν	Y	E3E17AA
Z620 Xeon E5-2643 v2 6C 3.50 25MB 1866 CPU2	Ν	Y	E3E10AA
Z620 Xeon E5-2680 v2 10C 2.80 25MB 1866 CPU2	Ν	Y	E3E15AA

NOTE 1: When ordering two processors, the second processor must be the same as the first. Intel processor numbers are not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families. See: http://www.intel.com/products/processor_number/ for details.

Multi-Core technologies are designed to improve performance of multithreaded software products and hardware-aware multitasking operating systems and may require appropriate operating system software for full benefits; check with software provider to determine suitability; Not all customers or software applications will necessarily benefit from use of these technologies.

64-bit computing on Intel® 64 architecture requires a computer system with a processor, chipset, BIOS, operating system, device drivers, and applications enabled for Intel® 64 architecture. Processor will not operate (including 32-bit operation) without an Intel® 64 architecture-enabled BIOS. Performance will vary depending on your hardware and software configurations. See: http://www.intel.com/info/em64t for more information.

Intel's numbering is not a measurement of higher performance.

- Z620 processor AMO kits include:
- 2nd CPU/Memory Module (riser)
- processor
- heat sink

SAS Hard Drives		Factory Configured	Option Kit	Option Kit Part Supp Number Note			
	HP SAS (Serial Attached SCSI) Hard Drives for HP Workstations						
	HP 300GB SAS 10K SFF HDD	Y	Y	A2Z20AA			
	HP 600GB SAS 10K SFF HDD	Y	Y	A2Z21AA			
	HP 900GB SAS 10K SFF HDD	Y	Y	E2P03AA			
	300GB SAS 15K rpm 6Gb/s 3.5" HDD	Y	Y	LU967AA			
	450GB SAS 15K rpm 6Gb/s 3.5" HDD	Y	Y	LU968AA			
	600GB SAS 15K rpm 6Gb/s 3.5" HDD	Y	Y	VM647AA			
	HP 900GB SAS 10K SFF HDD	Y	Y	E2P03AA			
	HP 1.2TB SAS 10K SFF HDD	Y	Y	E2P04AA			
	Sub-Section Description/Notes						
	NOTE: SAS Controller add-in card required						
SATA Hard Drives	SATA (Serial ATA) Hard Drives for HP Workstatio	ns					
	500GB SATA 7200 rpm 6Gb/s 3.5" HDD	Y	Y	LQ036AA			
	500GB SATA 7.2K SED SFF HDD	Y	Y	D8N29AA			
	1TB SATA 7200 rpm 6Gb/s 3.5" HDD	Y	Y	LQ037AA			
	2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD	Y	Y	QB576AA			
	3.0TB SATA 7200 rpm 6Gb/s 3.5" HDD	Y	Y	QF298AA			
	250GB SATA 10K rpm SFF HDD	Y	Y	B8X18AA			
	500GB SATA 10K rpm SFF HDD	Y	Y	B8X19AA			
	1TB SATA 10K rpm SFF HDD	Y	Y	B8X20AA			
SATA Solid State	HP Solid State Drives (SSDs) for Workstations						

Supported Components

Drives	HP 128GB SATA 6Gb/s SSD	Y	Y	A3D25AA
	HP 256GB SATA 6Gb/s SSD	Y	Y	A3D26AA
	HP 256GB SATA 6Gb/s SED SSD	Y	Y	D8N28AA
	HP 512GB SATA 6Gb/s SSD	Y	Ν	D8F30AA
	Intel Pro 1500 180GB SATA SSD	Y	Y	F5Z70AA
	Samsung SM843T 240GB SATA SSD	Y	Y	F0W94AA
	Samsung SM843T 480GB SATA SSD	Y	Y	F0W95AA
PCIe SSDs	PCIe SSDs for HP Workstations			
	HP Z Turbo Drive 256GB SSD*	Y	Y	G3G88AA
	HP Z Turbo Drive 512GB SSD*	Y	Y	G3G89AA
	Fusion ioFX 410GB PCIe Accelerator	Y	Y	E4W49AA
	* Each drive requires a PCIe x4 (minimum) slot to	he available. Ful	Inerform	nance is obtained

* Each drive requires a PCIe x4 (minimum) slot to be available. Full performance is obtained only when using PCIe slots connected to the CPU. Non-CPU PCIe slots may see a decrease of up to 10%. Please see slot configuration recommendations at www.hp.com/go/zturbo. Note that graphics cards, Thunderbolt[™], and other devices will require PCIe slots. For hard drives, 1 GB = 1 billion bytes; TB = 1 trillion bytes. Actual formatted capacity is less. Up to 12 GB of hard drive (or system disk) is reserved for the system recovery software (XP and XP Pro). Up to 3 GB of system disk is reserved for system recovery software (Vista).

Up to 4 drives are allowed. The 4th drive will occupy one of the external 5.25" bays.

Hard Drive Controllers		Factory Configured	Option Kit	Option Kit Part Support Number Notes					
	Integrated SATA 6.0 Gb/s Controller								
	Integrated SATA 6.0 Gb/s Controller	Y	Ν	Two ports					
	Integrated SATA 3.0 Gb/s Controller								
	Integrated SATA 3.0 Gb/s Controller	Y	Ν	Eight ports					
	Factory integrated RAID on motherboard for SATA drives								
	RAID 0 Configuration - Striped Array	Y	Ν	See note 1					
	RAID 1 Configuration - Mirrored Array	Y	Ν	See note 1					
	RAID 10 Configuration - Striped/Mirrored Array	Y	Ν	See note 1					
	RAID 0 Data Configuration Boot/OS Drive + 2 Drive Striped Array	Y	Ν	See note 1					
	LSI 9217-4i4e 8-port SAS 6Gb/s RAID Card								
	LSI 9217-4i4e 8-port SAS 6Gb/s RAID Card	Y	Y	E0X20AA					
	LSI 9270-8i SAS 6Gb/s ROC RAID Card	Y	Y						
	LSI 9270-8i SAS 6Gb/s ROC RAID Card	Y	Y	E0X21AA					
	RAID arrays greater than 2 TB are fully supported. NOTE 1 : Requires 2 identical hard drives (speeds, cap a 3rd HDD.		·						

NOTE: Specific user-configured hardware SAS RAID configurations are supported on this system with Linux. For details, please visit: http://www.hp.com/support/linux_hardware_matrix SATA hardware RAID is supported on Linux systems that have support for the Intel RSTe technology. The Linux kernel, with built-in software RAID, provides excellent functionality and performance. It is a good alternative to hardware-based RAID. Please visit



Supported Components

http://www.hp.com/support/linux_hardware_matrix for RAID capabilities with Linux.

NOTE: Specific user-configured hardware SAS RAID configurations are supported on this Linux system. IS: Striping of 2 or more HDDs into a single logical volume IM: Mirroring of 2 HDDs into a single logical volume IME: Mirroring of 3 or more HDDs into a single logical volume For details, please visit: http://www.hp.com/support/linux_hardware_matrix

Graphics

	Factory	Option	Option Kit Part		Supported	
	Configured	Kit		Support Notes	# of cards	Mixed?
Professional 2D						
NVIDIA NVS 310 512MB Graphics	Y	Y	A7U59AA		4	Yes
NVIDIA NVS 315 1GB Graphics	Y	Y	E1U66AA		4	No
NVIDIA NVS 510 2GB Graphics	Y	Y	C2J98AA	Note 1	2	Yes

Graphics Cable Adapters

	Factory	Option	Option Kit Part	Supp	orted
	Configured	Kit		Support Notes # of cards	Mixed?
HP DisplayPort To DVI-D Adapter (4-Pack)	Y	Ν		1	
HP DisplayPort To VGA Adapter 2nd	Y	Ν		1	
HP DisplayPort To DVI-D Adapter (6-Pack)	Y	Ν		1	
HP DisplayPort To DVI-D Adapter (2-Pack)	Y	Ν		1	
HP DisplayPort to Dual Link DVI Adapter	Y	Y	NR078AA	1	
HP DisplayPort To VGA Adapter	Y	Y	AS615AA	1	
HP DisplayPort To DVI-D Adapter	Y	Y	FH973AA	1	
Entry 3D					
NVIDIA Quadro 410 512MB Graphics	Y	Y	A7U60AA	2	No
NVIDIA Quadro K600 1GB Graphics	Y	Y	C2J92AA	2	No
AMD FirePro V3900 1GB Graphics	Y	Y	A6R69AA	2	No
Mid-range 3D					
NVIDIA Quadro K2000 2GB Graphics	Y	Y	C2J93AA	2	No
High End 3D					
NVIDIA Quadro K4000 3GB Graphics	Y	Y	C2J94AA	2	No
NVIDIA Quadro K5000 4GB Graphics	Y	Y	C2J95AA	2	No
AMD FirePro W7000 4GB Graphics	Y	Y	C2K00AA	2	No
NVIDIA Quadro K6000 12GB Graphics	Y	Y	C2J96AA	1	No
NOTE 1: If 1st card is NVS 510, 2nd card must b	be NVS 510 or	NVS 310).		



Supported Components

High Performance GPU Computing		Factory Configured	Option Kit	Option Kit Part Number	Support Notes				
	NVIDIA Tesla K20c Compute Processor	Y	Y	C2J97AA	See note2				
	NVIDIA Tesla K40 Compute Processor	Y	Y	F4A88AA	See note 1				
	 NOTE 1: Tesla K40 is supported with QK5000, QK600 or QK2000. Not supported with 2 graphics cards. Not supported with OS WIN32. Not supported with OS WIN8.0. NOTE 2: Tesla K20 is supported in combination with NVIDIA Quadro K600/K2000/K4000 1s graphics. Not supported with Win7 32-bit OS. 								
Memory	СТО		on Kit Pa lumber	irt Supp	ort Notes				
	DDR3-1866 ECC Unbuffered DIMMs - CTO								
	2GB DDR3-1866 ECC Unbuffered RAM								
	4GB DDR3-1866 ECC Unbuffered RAM								
	8GB DDR3-1866 ECC Unbuffered RAM								
	DDR3-1866 ECC Registered DIMMs - CTO								
	4GB DDR3-1866 ECC Registered RAM								
	8GB DDR3-1866 ECC Registered RAM								
	16GB DDR3-1866 ECC Registered RAM								
	Sub-Section Description/Notes								
	The Z620 has a four-channel memory architecture. Four channels are associated with each processor. For optimal performance, populate a DIMM in each channel. With single-processor configurations, 8 DIMM slots are available. Four additional DIMM slots a available with the 2nd CPU & Memory Module.								
	АМО								
	DDR3-1600 ECC Registered DIMMs - AMO								
	4GB DDR3-1600 ECC Registered RAM	A	2Z49AA						
	8GB DDR3-1600 ECC Registered RAM	A	2Z51AA						
	16GB DDR3-1600 ECC Registered RAM	A	2Z52AA						
	DDR3-1600 ECC Unbuffered DIMMs - AMO								
	HP 2GB (1x2GB) DDR3-1600 ECC RAM	A	2Z47AA						
	HP 4GB (1x4GB) DDR3-1600 ECC RAM	A	2Z48AA						
	DDR3-1866 ECC Unbuffered DIMMs - AMO								
	HP 2GB (1x2GB) DDR3-1866 ECC RAM E2Q90AA								
	HP 4GB (1x4GB) DDR3-1866 ECC RAM E2Q91AA								
	DDR3-1866 ECC Registered DIMMs - AMO								
	HP 4GB (1x4GB) DDR3-1866 ECC Reg RAM	E2	2Q92AA						
	HP 8GB (1x8GB) DDR3-1866 ECC Reg RAM E2Q94AA								
	HP 16GB (1x16GB) DDR3-1866 ECC Reg RAM	M E2	2Q95AA						

NOTE: Although all of these memory selections incorporate 1600MHz or 1866MHz memory modules, the speed at which they operate is dependent upon the processor.



Supported Components

Multimedia and Audio Devices	Factory Configure	•	Option Kit Part Number	Support Notes
Creative Recon3D PCIe	Audio Card Y	Y	B0U68AA	
Integrated Intel/Realtek	HD ALC262 Audio Y	Ν		
HP Thin USB Powered S	Speakers Y	Y	KK912AA	

Optical and Removable Storage		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP 16X DVD-ROM SATA Drive (non-Lightscribe version)	Y	Y	AR629AA	See note 1
	HP 16X DVD+/-RW SuperMulti SATA Drive (non-Lightscribe)	Y	Y	QS208AA	
	HP Blu-ray Writer	Y	Y	AR482AA	See note 2
	HP DX115 Removable Drive Enclosure				
	HP DX115 Carrier with 160GB SATA HDD	Ν	Y	FZ577AA	
	HP DX115 Removable HDD Frame/Carrier	Ν	Y	FZ576AA	
	HP DX115 Removable HDD Carrier	Ν	Y	NB792AA	
	HP 15-in-1 Media Card Reader				
	HP 15-in-1 Media Card Reader	Y	Y	G1S79AA	

Actual speeds may vary. Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

As Blu-ray is a new format containing new technologies, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

NOTE 1: Not supported as a 2nd Optical Drive. **NOTE 2:** Cannot be ordered in combination with another Blu-ray Writer.

Controller Cards		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP IEEE 1394b FireWire PCIe Card	Y	Y	NK653AA	
	HP Thunderbolt-2 PCIe 1-port I/O Card	Y	Y	F3F43AA	

HP Z620 Workstation

Supported Components

Networking and Communications		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Integrated Intel 82579LM PCIe GbE Controller	Y	Ν		See note 2
	Broadcom NetXtreme Gigabit Ethernet Plus NIC (PCIe)	Y	Y	FS215AA	See notes 1 and 2
	Intel Gigabit CT Desktop NIC	Ν	Y	FH969AA	See note 2
	HP X520 10GbE Dual Port Adapter	Y	Y	C3N52AA	See note 2
	HP 10GbE SFP+ SR Transceiver	Y	Y	C3N53AA	See note 2
	HP 361T PCIe Dual Port Gigabit NIC	Ν	Y	C3N37AA	See note 2
	Intel Ethernet I210-T1 PCIe NIC	Y	Y	E0X95AA	See note 2
	NOTE 1 : This is a PCI Express card based on th support DASH 1.1 manageability on this platform NOTE 2 : "Gigabit" Ethernet indicates compliance	1.			

Ethernet, and does not connote actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

Racking and Physical Security		Factory Configured	Option Kit		pport otes
	Security Cable with Kensington Lock	Ν	Y	PC766A	
	HP (CMT) Solenoid Lock	Ν	Y	DE618A	
	HP Solenoid Hood Lock & Hood Sensor	Y	Ν		
	HP Z6/8 Adjustable Rail Rack Kit, Flush Mount	Ν	Y	B8S55AA	

Input Devices		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP PS/2 Keyboard	Y	Y	QY774AA	
	HP PS/2 Mouse	Y	Y	QY775AA	
	HP USB Keyboard	Y	Y	QY776AA	
	HP USB Optical Mouse	Y	Y	QY777AA	
	HP USB 1000dpi Laser Mouse	Y	Y	QY778AA	
	HP Wireless Keyboard and Mouse	Ν	Y	QY449AA	
	HP USB Smart Card Keyboard	Ν	Y	E6D77AA	
	HP USB Optical 3-Button 2.9M OEM Mouse	Ν	Y	ET424AA	
	HP SpaceMouse Pro USB 3D Input Device	Ν	Y	B4A20AA	
	HP SpacePilot Pro 3D USB Intelligent Controller	N	Y	WH343AA	
	Product numbers QY774AA-QY778AA represen design. The previous models will be phased out of		2 product	s with the upo	dated product



Supported Components

Other Hardware

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP Workstation Mouse Pad	Y	Ν		Japan only.
HP Power Cord Kit	Ν	Y	DM293A	
HP eSATA PCI Cable Kit	Ν	Y	GM110AA	No hot plug / hot swap supported.
HP Serial Port Adapter	Ν	Y	PA716A	
HP Internal USB Port Kit	Ν	Y	EM165AA	Note 1
HP Optical Bay HDD Mounting Bracket	Y	Y	NQ099AA	For 3.5" HDDs
HP Energy Star Enabled Configuration	Y	Ν		
Note 1: The HD Internal LISB Port kit has a sir	ale LISB 2.0 tvr		pector	

Note 1: The HP Internal USB Port kit has a single USB 2.0 type A connector.

Software		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP Performance Advisor	Y	Y		See note 1
	HP Remote Graphics Software (RGS) 6.0	Y	Ν		See note 2
	HP ProtectTools Security	Y	Ν		See note 3
	HP Power Assistant	Y	Ν		Win7 only
	PDF Complete - Trial Edition	Y	Ν		
	Cyberlink Media Suite & PowerDVD	Y	Ν		Media playback and authoring software
	MS Office Home & Business 2013	Y	Ν		See note 3
	NOTE 1 : Available as a free download here: ww NOTE 2 : Supports both 32 and 64 bit versions of Windows XP Professional and Enterprise, and F NOTE 3 : Must select as a Configure to Order of Supported with Windows 7 Ultimate. Not Support	of Windows 7 Pro RHEL V6 ption. Delivered a	ofessional	I and Enter	•



Supported Components

Operating Systems

	Support Notes
Genuine Windows® 7 Ultimate 64-bit	See note 1
Genuine Windows® 7 Professional 64-bit	See note 1
Genuine Windows® 7 Professional 32-bit	See note 1
HP Linux Installer Kit	
Red Hat Enterprise Linux (RHEL) Workstation - Paper License (1yr)	
Windows 8.1 Pro 64-bit	
Windows 8.1 Simplified Chinese Edition 64-bit	
Windows 8.1 Pro Downgrade to Windows 7 Professional 64-bit	
Windows 8.1 Pro Downgrade to Windows 7 Professional 64-bit (National Academic)	
Windows 8.1 Pro Downgrade to Windows 7 Professional 32-bit	
Windows 8.1 Pro Downgrade to Windows 7 Professional 32-bit (National Academic)	

NOTE 1: See http://www.microsoft.com/windows/windows-7/ for support details. **NOTE 2:** This second OS must be ordered with the HP Linux Intaller Kit as the first OS.



Systom E	n Board										
System L	Board Form Fa		2nd CPU/ 14.9 x 2	cm 2 inches /Memory I	Board (opt	ional):					
Processo	r Socket		LGA2011								
			1st CPU 2nd CPU		n board al 2nd CP	U/Memory	y Module				
CPU Bus	Speed		QPI: Up t	Up to 8.0GT/second, depending on processor							
Chipset			Intel C602	2 Chipset							
Super I/C	Controller		Nuvoton N	NPCD379	H (SIO-12)						
Memory Expansion Slots 8 on system board(CPU0) + 4 on optional 2nd CPU/Memory Module (CPU1)											
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	Speed Suppo	rted	1066, 133					•			
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96¤ UDIMM¤	8GB¤	٥ <u>ټ</u>	8GB¤	°¤	۵¤	8GB¤	۵¤	8GB¤	8GB¤	8GB¤	8GB¤	8GB ^p
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128¤ RDIMM¤	16GB¤	٥Ħ	16GB¤	٥ï	°¤	16GB¤	٥Ħ	16GB¤	16GB¤	16GB¤	16GB¤	16GB
160¤ RDIMM¤	16GB¤	8GB¤	16GB¤	8GB¤	8GB¤	16GB¤	8GB¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB
192¤ RDIMM¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB
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	 (number) = number of lanes supported electrically. Typically communicated as x# mechanical, x(#)electrical. ** open-ended connector allow a greater bandwidth (e.g. x16) card to be installed physically into a lower bandwidth connector/slot. 		
PCI Connectors (5.0V)	Slot 6: PCI 32bit/33MHz Full-height, Full-length (with extender)		
Supported Drive Interfaces	SATA	Integrated 10-channel SATA interface (2@6Gb/s, 8@3Gb/s). Supports RAID 0, 1, 5, 10 and NCQ. Factory integrated RAID is Microsoft Windows only	
	Serial Attached SCSI	Requires Optional PCIe card	
Integrated RAID	 Integrated SATA RAID RAID 0, RAID 1*, RAID 5, RAID 10 Supports one RAID array with 2-4 drives RAID 0 configuration - striped array (supported and configure to order) RAID 1 configuration - mirrored array (supported and configure to order) RAID 5 parity striping (supported but not configure to order) RAID 10 striped and mirrored array 		
	*HW RAID functionality not supp the Red Hat Operating system in	orted by Linux. Use SW RAID functionality provided in	
Integrated Graphics	No		
Network Controller	 No Integrated Intel 82579 and 82574 Controllers. Memory Integrated 48KB receive buffer and 8KB transmit buffer Data rates supported 10/100/1000 Mb/s Compliance IEEE 802.3, 802.3AB and 802.3u compliant, 802.3x flow control Bus architecture PCIe 1.0a Data path width X1 Data path speed 2.5Gbit per sec per direction transfer rate Data transfer mode Bus-master DMA Power requirement 1.0 watts @ +3.3V AUX supply Boot ROM support Yes Network transfer rate 10BASE-T (half-duplex) 10 Mb/s 10BASE-T (full-duplex) 20 Mb/s 100BASE-TX (half-duplex) 100 Mb/s 100BASE-TX (full-duplex) 2000 Mb/s Microsoft Windows Vista Business 32 and 64, Microsoft Windows XP Professiona 32 and 64 Management capabilities AMT/vPro Technology 		
SATA Connectors	10 ports/connectors (6 ports may be cabled to optional eSATA cable kits [2 ports per cable kit]) No hot plug / hot swap supported.		
IEEE 1394a or 1394b	1394a is integrated 1394b is optional with PCIe card Cable from Front IO can be plugged into PCIe Card. Not supported in Linux		
IEEE 1394 Connector(s)	Front	1 - 1394a	
	Rear	1 - 1394a	
	Internal	No	
USB Connector(s)	Front	1 - USB 2.0 2 - USB 3.0	
	Rear	4 - USB 2.0 2 - USB 3.0	



	Internal		6 USB 2.0 ports available with three separat headers. Each header supports either a HP USB Port Kit (EM165AA) or USB Media Car reader. Each Internal Port Kit has one (1) USB 2.0 connector. Third-Party adaptors are available convert the 2x5 headers to two USB 2.0 connectors. For these solutions, the adaptor include a minimum of 8 inches of cable betw the 2x5 female connector and the USB 2.0 connector to insure sufficient cable-routing left	Internal rd e to r should veen	
HD Integrated Audio	Realtek ALC262)		Jingun	
Flash ROM	Yes	-			
CPU Fan Header	One for each C	PU socket			
Chassis Fan Header	Rear System C	hassis Fan Header hassis Fan Header			
CMOS Battery Holder – Lithium					
Integrated Trusted Platform Module	TPM 1.2, Infineon				
Power Supply Headers	Yes				
Power Switch, Power LED & Hard Drive LED Header	Yes (includes s	peaker and intrusion	sensor signals)		
Clear Password Jumper	Yes				
Serial Port	Optional				
Parallel Port	No				
Keyboard/Mouse	PS/2				
Z620 Required Power Supply In	fo				
Power Supply		800W 90% Efficient, Custom PSU (Wide Ranging, Active PFC)			
Operating Voltage Range		90–269 VAC			
Rated Voltage Range		100–24	118 V		
Rated Line Frequency		50–60	Hz 400 Hz		
Operating Line Frequency Rang	je	47–66	Hz 393–407 Hz		
Rated Input Current		9.7 A @ 10			
Heat Dissipation (Configuration and software dep	pendent)		Гурісаl = 1972 btu/hr (497 kcal/hr) aximum = 3139 btu/hr (791 kcal/hr)		
Power Supply Fan			92x25 mm variable speed		
ENERGY STAR Qualified (Configuration dependent)		Yes			
80 PLUS® Compliant			Yes, 90% Efficient		
		The Z620 800W power supply efficiency report can be found at this link: S10-800P1A			
FEMP Standby Power Complian (<2W in S5 - Power Off)	t @115V	Yes			
EuP Compliant @ 230V (<0.5 W in S5 - Power Off)		Yes			
CECP Compliant @ 220V (<4W in S3 - Suspend to RAM)		Yes; Configuration dependent			



· ·				
Power Consumption in sleep m (as defined by ENERGY STAR) - S (S3) (Instantly Available PC)		<15W		
Built-in Selft Test LED		Yes		
Surge Tolerant Full Ranging Po (withstands power surges up to		Yes		
Access Panel Solenoid Lock Header	Yes			
Access Panel Intrusion Sensor Header	Yes Integrated in Front User Interface (Power Switch, Power LED, HDD LED, Speaker) Cable			
Multibay Header	No			
Integrated Gigabit Ethernet	Integrated Intel	82579 and 82574 Controllers		
Wake on LAN	Yes			
ASF 1.0/2.0 (Alert Standard Format)	No			
ТРМ	Integrated TPM 1.2; Infineon			
Password Clear Header	Yes			
AUX IN (audio)	No			
Clear CMOS Button	Yes			
Memory Fan Header	CPU0 Memory Fan Header; CPU1 Memory Fan Header			

System Configuration

Example Configuration	Processor Info	1x Intel Xeo	n E5-2650 (E	Eight-Core)			
#1	Memory Info	4x 2GB DDF	R3 1600 (UD	NMM)			
(ENERGY STAR	Graphics Info	1x NVIDIA C	Quadro 600				
QUALIFIED)	Disks/Optical/Floppy	1x 250GB S	ATA 7200/1	x 16X DVD-	ROM SATA		
	Power Supply	800W 90% Custom PSU					
	Other	1x NVIDIA T	esla C2075				
Energy Consumption		115	VAC	230	VAC	100	VAC
		LAN Enabled LAN Disabled LAN Enabled LAN Disabled LAN Enabled LAN Disa			LAN Disabled		
	Windows Idle (S0)	111 W 110 W 111 W			W		
	Windows Busy Typ (S0))) 287 W 276 W 286 W		6 W			
	Windows Busy Max (S0)	- 1		390 W		398 W	
	Sleep (S3)	4.25 W	4.10 W	4.43 W	4.31 W	4.25 W	4.11 W
	Off (S5)	1.81 W	1.62 W	2.07 W	1.89 W	1.79 W	1.61 W
	Zero Power Mode (ErP)	0.2	5 W	0.4	5 W	0.2	3 W
Heat Dissipation**		115	VAC	230	VAC	100	VAC
-		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	379 b	otu/hr	375 k	otu/hr	379 b	otu/hr
	Windows Busy Typ (S0)) 979 btu/hr		942 btu/hr		976 btu/hr	
	Windows Busy Max (S0)	1351	btu/hr	1331	btu/hr	1358	btu/hr
	Sleep (S3)	14.5 btu/hr	14.0 btu/hr	15.1 btu/hr	14.7 btu/hr	14.5 btu/hr	14.0 btu/hr
	Off (S5)	6.18 btu/hr	5.53 btu/hr	7.06 btu/hr	6.45 btu/hr	6.11 btu/hr	5.49 btu/hr
	Zero Power Mode (ErP)	0.85	btu/hr	1.54	btu/hr	0.78	otu/hr



Example Configuration	Processor Info	1x Intel Xeo	n E5-2643 (F	our-Core)			
#2	Memory Info	4x 4GB DDF	R3 1600 (UD	NMM)			
(ENERGY STAR	Graphics Info	1x NVIDIA N	VVS 300				
QUALIFIED)	Disks/Optical/Floppy	2x 500GB S	ATA 7200/1	x 16X DVD-l	ROM SATA		
	Power Supply	800W 90% Custom PSU					
	Other	-					
Energy Consumption		115	VAC	230	VAC	100	VAC
	<u></u>	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	66.8 W 66.3 W 66.9 W		9 W			
	Windows Busy Typ (S0)	D) 170 W 169 W 171 W		W			
	Windows Busy Max (S0)) 193 W		190 W		193 W	
	Sleep (S3)	4.43 W	4.31 W	4.62 W	4.51 W	4.43 W	4.33 W
	Off (S5)	1.81 W	1.38 W	2.07 W	1.64 W	1.78 W	1.36 W
	Zero Power Mode (ErP)	0.24	4 W	0.4	5 W	0.23	3 W
Heat Dissipation**		115	VAC	230	VAC	100	VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	228 b	otu/hr	226 b	otu/hr	228 b	otu/hr
	Windows Busy Typ (S0)) 580 btu/hr		577 btu/hr		583 btu/hr	
	Windows Busy Max (S0)) 659 btu/hr		648 btu/hr		659 btu/hr	
	Sleep (S3)	15.1 btu/hr	14.7 btu/hr	15.8 btu/hr	15.4 btu/hr	15.1 btu/hr	14.8 btu/hr
	Off (S5)	6.18 btu/hr	4.71 btu/hr	7.06 btu/hr	5.60 btu/hr	6.07 btu/hr	4.64 btu/hr
	Zero Power Mode (ErP)	0.82	btu/hr	1.54	btu/hr	0.78 8	otu/hr

1	1	1					
Example Configuration		2x Intel Xeo	•	• /			
#3	Memory Info	8x 8GB DDF	R3 1600 (RD	DIMM)			
(ENERGY STAR	Graphics Info	1x NVIDIA C	Quadro 2000				
QUALIFIED)	Disks/Optical/Floppy	2x 250GB S	ATA 7200/1	x 16X DVD+	RW Superl	Multi SATA	
	Power Supply	800W 90%	Custom PSI	J			
	Other	-					
Energy Consumption		115 VAC 230 VAC 100 VAC			VAC		
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	121 W 120 W 122 W			2 W		
	Windows Busy Typ (S0)) 506 W 494 W 518 W			3 W		
	Windows Busy Max (S0)) 541 W		531 W		544 W	
	Sleep (S3)	7.75 W	7.57 W	7.84 W	7.67 W	7.82 W	7.62 W
	Off (S5)	1.97 W	1.57 W	2.18 W	1.82 W	1.96 W	1.55 W
	Zero Power Mode (ErP)	0.24	4 W	0.4	4 W	0.2	3 W
Heat Dissipation**		115	VAC	230	VAC	100	VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	413 b	otu/hr	409 k	otu/hr	416 b	otu/hr
	Windows Busy Typ (S0)) 1727 btu/hr		1686 btu/hr		1767 btu/hr	
	Windows Busy Max (S0)) 1846 btu/hr		1812 btu/hr		1856 btu/hr	
	Sleep (S3)	26.4 btu/hr	25.8 btu/hr	26.8 btu/hr	26.2 btu/hr	26.7 btu/hr	26.0 btu/hr
	Off (S5)	6.72 btu/hr	5.36 btu/hr	7.44 btu/hr	6.21 btu/hr	6.69 btu/hr	5.29 btu/hr
	Zero Power Mode (ErP)	0.82	btu/hr	1.50	btu/hr	0.78	btu/hr



Example Configuration	Processor Info	2x Intel Xeo	n E5-2620 (S	Six-Core)			
#4	Memory Info	12x 4GB DD)R3 1600 (Ù	DIMM)			
	Graphics Info	2x NVIDIA (Quadro 5000				
	Disks/Optical/Floppy	4x 600GB S	SAS 15K/1x	16X DVD+-F	RW SuperMu	ılti SATA	
	Power Supply	800W 90% Custom PSU					
	Other	LSI 9212 SA	AS Card				
Energy Consumption		115 VAC 230 VAC 100 VAC					
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	216 W 213 W 217 W		7 W			
	Windows Busy Typ (S0)) 525 W 485 W		5 W	512 W		
	Windows Busy Max (S0)) 644 W		631 W		647 W	
	Sleep (S3)	9.27 W	8.81 W	9.36 W	8.91 W	9.31 W	8.89 W
	Off (S5)	1.85 W	1.43 W	2.12 W	1.68 W	1.83 W	1.41 W
	Zero Power Mode (ErP)	0.2	5 W	0.4	5 W	0.2	3 W
Heat Dissipation**		115	VAC	230	VAC	100	VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	737 t	otu/hr	727 t	otu/hr	740 k	otu/hr
	Windows Busy Typ (S0)	1791	btu/hr	1655	btu/hr	1747	btu/hr
	Windows Busy Max (S0)	2197	btu/hr	2153	btu/hr	2208	btu/hr
	Sleep (S3)	31.6 btu/hr	30.1 btu/hr	31.9 btu/hr	30.4 btu/hr	31.8 btu/hr	30.3 btu/hr
	Off (S5)	6.31 btu/hr	4.88 btu/hr	7.23 btu/hr	5.73 btu/hr	6.24 btu/hr	4.81 btu/hr
	Zero Power Mode (ErP)	0.85	btu/hr	1.54	btu/hr	0.78	btu/hr

Declared Noise Emissions (Entry-level and High-end configurations)				
System Configuration	Processor Info	Single Intel Xeon E5-2640 2.50 GHz		
(Entry level)	Memory Info	4 - 2 GB DDR3 1333 MHz UDIMM		
	Graphics Info	NVIDIA Q400		
	Disks/Optical/Floppy	Single 1 TB 7200 RPM SATA DVD ROM		

Declared Noise Emissions (in		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
accordance with ISO	Idle	3.3	16
7779 and ISO 9296)	Hard drive Operating (random reads)	3.9	22
	DVD-ROM Operating (sequential reads)	5.1	39

System Configuration	Processor Info	Dual Xeon E5-2690 2.90 GHz
(High-end)	Memory Info	12 - 4GB DDR3 1600 MHz UDIMM
Graphics Info NVIDIA Q4000		NVIDIA Q4000
	Disks/Optical/Floppy	Dual 600 GB 15K RPM SAS 3.5"
		DVD ROM



Declared Noise Emissions (in		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
accordance with ISO	Idle	4.4	29
7779 and ISO 9296)	Hard drive Operating (random reads)	4.8	32
	DVD-ROM Operating (sequential reads)	5.1	36

Environmental Requirements	Temperature	Operating: 5°C to 35°C (40°F to 95°F) Non-operating: -40°C to 60°C (-40°F to 140°F)
	Humidity	Operating: 8% to 85% RH, non-condensing Non-operating: 8% to 90% RH, non-condensing
	Maximum Altitude	Operating: 3,048 m (10,000 ft) Non-operating: 9,144 m (30,000 ft)
	Dynamic (new)	 Shock Operating: ½-sine: 40 g, 2-3ms (~62 cm/sec) Non-operating: ½-sine: 160 cm/s, 2-3ms (~105 g) square: 20 g, 422 cm/s NOTE: Values represent individual shock events and do not indicate repetitive shock events. Vibration Operating random: 0.5 g (rms), 5-300 Hz, up to 0.0025 g²/Hz Non-operating random: 2.0 g (rms), 5-500 Hz, up to 0.0150 g²/Hz NOTE: Values do not indicate continuous vibration.
	Cooling	Above 1524m (5,000 ft) altitude, maximum operating temperature is de- rated by 1°C (1.8°F) per 305m (1,000 ft) elevation increase

Physical Securit	y and Serviceability			
Access Panel	Tool-less Includes system board and memory information			
Optical Drive	Tool-less, no carrier or rails required			
Hard Drives	Tool-less Integrated blind-mate drive carriers			
	Optional 5.25" external bay carriers			
Expansion Cards	Tool-less			
Processor Socket	1st socket on main system board. 2nd socket on optional 2nd CPU/Memory Module.			
Green User Touch Points	Yes, on primary serviceable components			
Color-coordinated Cables and Connectors	Yes			
Memory	Tool-less			
System Board	Tool-less 2nd CPU/Memory Module: Tool-less			
Dual Color Power and HD LED on Front of Computer	Yes			



Configuration Record SW	Yes			
Over-Temp Warning or Screen	Yes, at POST screen on reboot.			
Restore CD/DVD Set	Yes, restores the computer to its original factory shipping image - Can be obtained via HP Support.			
Dual Function Front Power Switch	Yes, also acts as a reset switch when held for 4 seconds.			
Padlock Support	No			
Cable Lock Support	Yes, Kensington Cable Lock (optional): Prevents entire system theft only. 3mm x 7mm slot at rear of system			
Universal Chassis Clamp Lock Support	No			
Solenoid Lock and Hood Sensor	Access Panel Solenoid Lock: Yes (optional). Activated remotely to prevent system entry. Access Panel Intrusion Sensor: Yes (optional).			
Rear Port Control Cover	No			
Removable Media Write/Boot Control	Yes, user can prevent the workstation from writing to or booting from removable media.			
Power-On Password	Yes, prevents an unauthorized person from booting up the computer.			
Setup Password	Yes, prevents an unauthorized person from changing the system configuration.			
3.3V Aux Power LED on System PCA	No			
NIC LEDs (integrated) (Green & Amber)	Yes			
CPUs and Heatsinks	CPU heatsink removal requires a T-15 Torx or flat blade screwdriver. CPU removal is tool-less.			
Power Supply Diagnostic LED	Yes			
Front Power Button	Yes			
Rear Power Button	Yes			
Front Power LED	Yes, blue (normal), red (fault)			
Front Hard Drive Activity LED	Yes, green			
Front ODD Activity LED	Yes			
Internal Speaker	Yes			
System/Emergency ROM Flash Recovery	Recovers corrupted system BIOS			
Cooling Solutions	Air cooled forced convection			
Power Supply Fans	1 - 92mm			
CPU Heatsink Fan	1st CPU: 1 - 92mm Optional 2nd CPU: 1 - 92mm			
Memory Heatsink Fan	System Board Memory: rear bank: 1 - 60mm, front bank: 1 - 40mm Optional 2nd CPU/Memory Module: rear bank: 1 - 80mm.			
HP Vision Diagnostics Offline Edition	HP Vision Diagnostics Offline Edition The diagnostics utility enables you to perform testing and to view critical computer hardware and software configuration information from various sources. This utility enables you to:			
	 Run diagnostics View the hardware configuration of the system 			



	 Key features and benefits HP Vision Diagnostics simplifies the process of effectively identifying, diagnosing, and isolating the hardware issues. In addition to robust management tools, service tools can be invaluable in quickly resolving system problems. To streamline the service process and resolve problems quickly, it is necessary to have the right information available at the time that a service call is placed. The primary information requirement, which is also the one that provides the greatest Vision into potential system issues, is the configuration of the system. Vision diagnostics helps provide higher system availability. Typical uses of the Vision Diagnostics are: Testing and diagnosing apparent hardware failures Documenting system configurations for upgrade planning, standardization, inventory tracking, disaster recovery, and maintenance Sending configuration information to another location for more in-depth analysis 			
Access Panel Key Lock	Yes, prevents removal of the access panel and all internal components including devices nstalled in the external 5.25" bays.			
ACPI-Ready Hardware	 Advanced Configuration and Power Management Interface (ACPI). Allows the system to wake from a low power mode Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system 			
Trusted Platform Module Chip with optional ProtectTools Software	Yes, Infineon SLB9635TT1.2			
Integrated Chassis Handles	Yes			
Power Supply	Tool-less. Includes integrated handle.			
PCI Card Retention	Yes, tool-less Rear (all) Middle (full-height cards) Front (full-length cards with extender)			
Flash ROM	SPI ROM			
Diagnostic Power Switch LED on board	Yes			
Clear Password Jumper	Yes			
Clear CMOS Button	Yes			
CMOS Battery Holder	Yes			
DIMM Connectors	Yes			
HP ProtectTools Security Manager	Yes - Not supported on Linux			

BIOS			
BIOS 32-bit Services	Standard BIOS 32-Bit Service Directory Proposal v0.4		
PCI 3.0 Support	ull BIOS support for PCI Express through industry standard interfaces		
ΑΤΑΡΙ	FAPI Removable Media Device BIOS Specification Version 1.0		
BBS	BIOS Boot Specification v1.01		
WMI Support	WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is fully compliant with the Distributed Management Task Force (DMTF) C Information Model (CIM) and WBEM specifications.		



BIOS Boot Spec 1.01+	Provides more control over how and from what devices the workstation will boot			
BIOS Power On	Users can define a specific date and time for the system to power on			
ROM Based Computer Setup Utility (F10)	Review and customize system configuration settings controlled by the BIOS			
System/Emergency ROM Flash Recovery with Video	Recovers system BIOS in corrupted Flash ROM			
Replicated Setup	Saves BIOS settings to diskette or USB flash device in human readable file. Repset.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).			
SMBIOS	System Management BIOS 2.7 for system management information			
Boot Control	Disables the ability to boot from removable media on supported devices			
Memory Change Alert	Alerts management console if memory is removed or changed			
Thermal Alert	Monitors the temperature state within the chassis. Three modes:			
	 NORMAL - normal temperature ranges. ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown. SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs. 			
Remote ROM Flash	Provides secure, fail-safe ROM image management from a central network console			
ACPI (Advanced Configuration and Power Management Interface)	Allows the system to enter and resume from low power modes (sleep states). Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system. Supports ACPI 2.0 for full compatibility with 64-bit operating systems.			
Ownership Tag	A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen			
Remote Wakeup/Remote Shutdown	System administrators can power on, restart, and power off a client computer from a remote location			
Instantly Available PC (Suspend to RAM - ACPI sleep state S3)	Allows for very low power consumption with quick resume time			
Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)	Allows a new or existing system to boot over the network and download software, including the operating system			
ROM revision levels	Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version i available through an industry standard interface (SMBIOS) so that management SW application can use and report this information.			
System board revision level	Allows management SW to read revision level of the system board Revision level is digitally encoded into the HW and cannot be modified			
Start-up Diagnostics (Power-on Self-Test)	Assesses system health at boot time with selectable levels of testing			
Auto Setup when new hardware installed	System automatically detects the addition of new hardware			
Keyboard-less Operation	The system can be booted without a keyboard			
Localized ROM Setup	Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings			
Asset Tag	Allows the user or MIS to set a unique tag string in non-volatile memor			



Per-slot Control	Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually			
Adaptive Cooling	Fan control parameters are set according to detected hardware configuration for optimal acoustics			
Pre-boot Diagnostics	Early (pre-video) critical errors are reported via beeps and blinks on the power LED			
Industry Standard Specification Support				
UEFI Specification Revision	2.3.1			
Industry Standard	Revision Supported by the BIOS			
ACPI	Advanced Configuration and Power Management Interface, Version 2.0			
ATA (IDE)	AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b			
CD Boot	"El Torito" Bootable CD-ROM Format Specification Version 1.0			
EDD	 Enhanced Disk Drive Specification Version 1.1 BIOS Enhanced Disk Drive Specification Version 3.0 			
EHCI	Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0			
PCI	 PCI Local Bus Specification, Revision 2.3 PCI Power Management Specification, Revision 1.1 PCI Firmware Specification, Revision 3.0, Draft 0.7 			
PCI Express	PCI Express Base Specification, Revision 2.0 PCI Express Base Specification, Revision 3.0			
РММ	POST Memory Manager Specification, Version 1.01			
SATA	 Serial ATA Specification, Revision 1.0a Serial ATA 3 Gb/s: Serial ATA Specification, Revision 2.5 Serial ATA 6 Gb/s: Serial ATA Specification, Revision 3.0 			
SPD	PC SDRAM Serial Presence Detect (SPD) Specification, Revision 1.2			
ТРМ	Trusted Computing Group TPM Specification Version 1.2			
UHCI	Universal Host Controller Interface Design Guide, Revision 1.1			
USB	Universal Serial Bus Revision 1.1 Specification Universal Serial Bus Revision 2.0 Specification Universal Serial Bus Revision 3.0 Specification			
SMBIOS	System Management BIOS Reference Specification, Version 2.7			

Social and Environmental Responsibility

1		
Eco-Label Certification & Declarations	s This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:	
	 ENERGY STAR® (energy-saving features available on selected configurations-Windows only) 	
	US Federal Energy Management Program (FEMP)	
	China Energy Conservation Program	
	IT ECO declaration	
Batteries	The battery in this product complies with EU Directive 2006/66/EC Battery size: CR2032 (coin cell) Battery type: Lithium Metal	
	The battery in this product does not contain:	
	Mercury greater than 5ppm by weight	
	 Cadmium greater than 10ppm by weight 	
	Lead greater than 40ppm by weight	



-			
Restricted Material Usage	This product meets the material restrictions specified in HP's General Specification for the Environment. http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf Hewlett-Packard is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis.		
Low Halogen Statemen	IT his product is low halogen except for power cords, cables and peripherals, as well as the following customer-configurable internal components: 3 ½" SAS HDDs, LSI 9260-8i SAS 6Gb/s ROC RAID Card, Creative Recon3D PCIe Audio Card, Liquid Cooling Solution and Broadcom 5761 Gigabit PCIe NIC are not Low Halogen. Service parts obtained after purchase may not be Low Halogen.		
End-of-Life	Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic		
Management and Recycling	areas. To recycle your product, please go to: http://www.hp.com/recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner. This product is greater than 90% recyclable by weight when properly disposed of at end of life.		
Hewlett-Packard	For more information about HP's commitment to the environment:		
Corporate Environmental Information	Global Citizenship Report: http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html		
	Eco-label certifications: http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html		
	ISO 14001 certificates:		
	http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html		
Additional Information	 This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC. Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043. This product is >90% recycle-able when properly disposed of at end of life. EPEAT Gold registered in the U.S. EPEAT registration varies by country. See www.epeat.net for registration status by country 		
Packaging	HP Workstation product packaging meets the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/society/gen_specifications.html		
	 Does not contain restricted substances listed in HP Standard 011-1 General Specification for the Environment Does not contain ozone-depleting substances (ODS) Does not contain heavy metals (lead, mercury, cadmium or hexavalent chromium) in excess of 100 ppm sum total for all heavy metals listed Maximizes the use of post-consumer recycled content materials in packaging materials All packaging material is recyclable All packaging material is designed for ease of disassembly Reduced size and weight of packages to improve transportation fuel efficiency Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards 		
	formatting		
Packaging Materials	tormatting		
Packaging Materials Internal	formatting Cushions and plastic bags made of low density polyethylene (LDPE).		

Manageability				
Industry Standard	This product meets the following industry standard specifications for manageability functionality:			
Specifications				
·	 DASH 1.1 required functionalities via Intel LAN on motherboard 			
Intel Active	Intel Active Management Technology (AMT) 7.0			
Management				



,			
Technology (AMT)	An advanced set of remote management features and functionality providing IT administrators the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state. AMT 7.0 includes the following advanced management functions:		
	 Power Management (on, off, reset) Hardware Inventory (includes BIOS and firmware revisions) Hardware Alerting Agent Presence System Defense Filters 		
	 SOL/IDER Cisco NAC/SDN Support ME Wake-on-LAN DASH 1.1 compliance 		
	 IPv6 Support Fast Call for Help - a client inside or outside the firewall may initiate a call for help via BIOS screen, periodic connections, or alert triggered connection Remote Scheduled Maintenance - pre-schedule when the system connects to the IT or service provider console for maintenance. Remote Alerts - automatically alert IT or service provider if issues arise 		
	 Access Monitor - Provides oversight into Intel® AMT actions to support security requirements PC Alarm Clock Microsoft NAP Support Host Base set-up and configuration 		
	Management Engine (ME) firmware roll back		
Intel® vPro™ Technology	The HP Z620 Workstation supports Intel vPro technology when configured as outlined below:		
	 Intel Xeon processor E5-1600 product family or E5-2600 product family featuring Intel vPro Technology Intel C602 chipset Intel 82579LM GbE LAN 		
Remote Manageability Software Solutions	 The HP Z620 Workstation is supported on the following remote manageability software consoles: LANDesk Management Suite (HP recommended solution) Microsoft System Center Configuration Manager HP Client Automation Enterprise 		
	For questions or support for manageability needs, please visit http://www.hp.com/go/easydeploy		
System Software Manager	For questions or support for SSM, please visit: http://www.hp.com/go/ssm		
Service, Support, and Warranty	On-site Warranty and Service (Note 1): Three-years, limited warranty and service offering delivers on-site, next business-day (Note 2) service for parts and labor and includes free telephone support (Note 3) 8am - 5pm. Global coverage (Note 2) ensures that any product purchased in one country and transferred to another, non-restricted country will remain fully covered under the original warranty and service offering.		
	NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply. NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country. NOTE 3: Technical telephone support applies only to HP-configured, HP and HP-qualified, third-party hardware and software. Toll-free calling and 24x7 support service may not be available in some countries.		
	HP Care Pack Services extend service contracts beyond the standard warranties. Service starts from date of hardware purchase. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/lookuptool. Additional HP Care Pack Services information by product is available at: http://www.hp.com/hps/carepack. Service		
	·		

	levels and response times for HP Care Packs may vary depending on your geographic location.		
Product Change Notification	 Program to proactively communicate Product Change Notifications (PCNs) and Customer Advisories by email to customers, based on a user-defined profile. PCNs provide advance notification of hardware and software changes to be implemented in the factory providing time to plan for transition. Customer Advisories provide concise, effective problem resolution, greatly reducing the need to call technical support. 		

Stable & Consistent Offerings

	this breakthrough Consistent Offerin software designed	As part of its commitment to hardware, software, and solution innovation, HP is proud to introduce this breakthrough platform configuration stability to HP Workstation customers. HP Stable & Consistent Offerings are built on the foundation of a carefully chosen set of hardware and software designed and tested to work with all HP Z Workstation platforms through their end of life. These components and their corresponding HP Workstation platform compatibility are outlined in this section. HP Stable & Consistent Offerings are available worldwide to all HP Workstation customers-no special programs, no additional cost-no kidding. Simply select your hardware and software components when you customize your HP Workstation and be assured that you'll be able to buy that same configuration throughout the lifecycle of the product.		
	special programs, components wher			
Processors	Product #	Offering		
	A2A06AV	Intel Xeon E5-2620 2 15M 1333 6C 1 CPU		
	A2A19AV	Intel Xeon E5-2620 2 15M 1333 6C 2 CPU		
	A2A09AV	Intel Xeon E5-2643 3.3 10M 1600 4C 1 CPU		
	A2A22AV	Intel Xeon E5-2643 3.3 10M 1600 4C 2 CPU		
Hard Drives	Product #	Offering		
	QG001AV	500GB 7200 RPM SATA 1st HDD		
	QG011AV	500GB 7200 RPM SATA 2nd HDD		
	QG021AV	500GB 7200 RPM SATA 3rd HDD		
	QG031AV	500GB 7200 RPM SATA 4th HDD		
	QG002AV	1TB 7200 RPM SATA 1st HDD		
	QG012AV	1TB 7200 RPM SATA 2nd HDD		
	QG022AV	1TB 7200 RPM SATA 3rd HDD		
	QG032AV	1TB 7200 RPM SATA 4th HDD		
Graphics	Product #	Offering		
-	A7U49AV	NVIDIA NVS 310 512MB GFX		
	A7U50AV	NVIDIA NVS 310 512MB 2nd GFX		
	A7U51AV	NVIDIA NVS 310 512MB 3rd GFX		
	A7U52AV	NVIDIA NVS 310 512MB 4th GFX		
	C2J48AV	NVIDIA Quadro K2000 2GB Graphics		
	C2J49AV	NVIDIA Quadro K2000 2GB Graphics		
Memory	Product #	Offering		
		Any configuration with 2GB DDR3-1866 ECC Unbuffered DIMMs		
		Any configuration with 4GB DDR3-1866 ECC Unbuffered DIMMs		
		Any configuration with 4GB DDR3-1866 ECC Registered DIMMs		
		Any configuration with 8GB DDR3-1866 ECC Registered DIMMs		
Optical and Rem	ovableProduct #	Offering		
Storage	QG049AV	16X SuperMulti DVDRW SATA 1st ODD		
	QG053AV	16x SuperMulti DVDRW SATA 2nd ODD		



Stable & Consistent Offerings

Operating Systems	Product #	Offering
	A8Z55AV	HP USB Optical Mouse (available June 2012)
	A8Z53AV	HP USB Keyboard (available June 2012)
Input Devices	Product #	Offering

LJ454AV

Offering

Windows 7 Professional 64-bit OS

Technical Specifications - Processors

Processors

Intel® Xeon® Processor E5-2620 6C 2.00GHz Intel® Xeon® Processor E5-2643 4C 3.30GHz

Introduction

The Intel® Xeon® processor E5-1600/E5-2600/E5-4600 product families are the next generation of 64-bit, multi-core enterprise processors built on 32-nanometer process technology. Throughout this document, the Intel® Xeon® processor E5-1600/E5-2600/E5-4600 product families may be referred to as simply the processor. Where information differs between the EP and EP 4S SKUs, this document uses specific Intel® Xeon® processor E5-1600 product family, Intel® Xeon® processor E5-2600 product family, and Intel® Xeon® processor E5-4600 product family notation.Based on the low-power/high performance 2nd Generation Intel® Core™ Processor Family microarchitecture, the processor is designed for a two chip platform consisting of a processor and a Platform Controller Hub (PCH) enabling higher performance, easier validation, and improved x-y footprint. The Intel® Xeon® processor E5-2600 product family are designed for Efficient Performance server, workstation and HPC platforms. The Intel® Xeon® processors, including "glueless" 4-way platforms. Note: some processor features are not available on all platforms. These processors feature per socket, two Intel® QuickPath Interconnect point-to-point links capable of up to 8.0 GT/s, up to 40 lanes of PCI Express* 3.0 links capable of 8.0 GT/s, and 4 lanes of DMI2/PCI Express* 2.0 interface with a peak transfer rate of 5.0 GT/s. The processor supports up to 46 bits of physical address space and 48-bit of virtual address space.

Included in this family of processors is an integrated memory controller (IMC) and integrated I/O (IIO) (such as PCI Express* and DMI2) on a single silicon die. This single die solution is known as a monolithic processor.

Performance and Features

- Up to 8 execution cores
- Each core supports two threads (Intel® Hyper-Threading Technology), up to 16 threads per socket
- 46-bit physical addressing and 48-bit virtual addressing
- 1 GB large page support for server applications
- A 32-KB instruction and 32-KB data first-level cache (L1) for each core
- A 256-KB shared instruction/data mid-level (L2) cache for each core
- Up to 20 MB last level cache (LLC): up

Intel® Xeon® Processor E5-1620 4C 3.60GHz Intel® Xeon® Processor E5-1603 4C 2.80GHz

Processor Note

For detailed processor specifications, please refer to the Overview section at the beginning of this document.

Z620 Xeon E5-2620 6C 2.00 15MB 1333 CPU2	A6S74AA
Z620 Xeon E5-2643 4C 3.30 10MB 1600 CPU2	A6S77AA

Introduction

The After Market Option kits for the Z620 processors include the "2nd CPU & Memory Module", the Intel Xeon processor, and the heatsink. Additional system memory must be ordered separately.



Technical Specifications - Processors

Intel® Xeon® Processor E5-2603 v2 4C 1.80GHz Intel® Xeon® Processor E5-2609 v2 4C 2.50GHz Intel® Xeon® Processor E5-2620 v2 6C 2.10GHz Intel® Xeon® Processor E5-2630 v2 6C 2.60GHz Intel® Xeon® Processor E5-2637 v2 4C 3.50GHz Intel® Xeon® Processor E5-2640 v2 8C 2.00GHz Intel® Xeon® Processor E5-2640 v2 8C 2.00GHz Intel® Xeon® Processor E5-2643 v2 6C 3.50GHz Intel® Xeon® Processor E5-2650 v2 8C 2.60GHz Intel® Xeon® Processor E5-2660 v2 10C 2.20GHz Intel® Xeon® Processor E5-2667 v2 8C 3.30GHz Intel® Xeon® Processor E5-2667 v2 8C 3.30GHz Intel® Xeon® Processor E5-2680 v2 10C 2.50GHz Intel® Xeon® Processor E5-2680 v2 10C 2.80GHz Intel® Xeon® Processor E5-2690 v2 10C 3.00GHz Intel® Xeon® Processor E5-2690 v2 12C 2.40GHz Intel® Xeon® Processor E5-2697 v2 12C 2.70GHz

Intel® Xeon® Processor E5-1607 v2 4C 3.00GHz Intel® Xeon® Processor E5-1620 v2 4C 3.70GHz Intel® Xeon® Processor E5-1650 v2 6C 3.50GHz Intel® Xeon® Processor E5-1660 v2 6C 3.70GHz Intel® Xeon® Processor E5-1680 v2 8C 3.00GHz

Z620 Xeon E5-2603 v2 4C 1.80 10MB 1333 CPU2 Z620 Xeon E5-2609 v2 4C 2.50 10MB 1333 CPU2 Z620 Xeon E5-2620 v2 6C 2.10 15MB 1600 CPU2 Z620 Xeon E5-2630 v2 6C 2.60 15MB 1600 CPU2 Z620 Xeon E5-2637 v2 4C 3.50 15MB 1866 CPU2 Z620 Xeon E5-2640 v2 8C 2.00 20MB 1600 CPU2 Z620 Xeon E5-2643 v2 6C 3.50 25MB 1866 CPU2 Z620 Xeon E5-2650 v2 8C 2.60 20MB 1866 CPU2 Z620 Xeon E5-2660 v2 10C 2.20 25MB 1866 CPU2 Z620 Xeon E5-2667 v2 8C 3.30 25MB 1866 CPU2 Z620 Xeon E5-2670 v2 10C 2.50 25MB 1866 CPU2 Z620 Xeon E5-2680 v2 10C 2.80 25MB 1866 CPU2 Z620 Xeon E5-2690 v2 10C 2.80 25MB 1866 CPU2 Z620 Xeon E5-2690 v2 10C 3.00 25MB 1866 CPU2 Z620 Xeon E5-2690 v2 10C 3.00 25MB 1866 CPU2 Z620 Xeon E5-2690 v2 12C 2.40 30MB 1866 CPU2 Z620 Xeon E5-2697 v2 12C 2.70 30MB 1866 CPU2

E3E05AA E3E06AA E3E07AA E3E09AA E3E10AA E3E11AA E3E12AA E3E13AA E3E14AA E3E15AA E3E15AA E3E16AA E3E17AA

E3E04AA



Technical Specifications - Hard Drives

HP SAS (Serial Attached SCSI) Hard Drives for HP Workstations	600GB SAS 15K rpm 6Gb/s 3.5" HDD	Capacity	600GB	
		Height	1 in; 2.54 cm	
		Width	Media Diameter	3.5 in; 8.9 cm
			Physical Size	4 in; 10.17 cm
		Interface	SAS	
		Synchronous Transfer Rate (Maximum)	6.0 Gb/s	
		Buffer	16 MB	
		Seek Time (typical reads, includes controller overhead, including settling)	Single Track	0.2 ms
			Average	3.4 ms
			Full Stroke	6.6 ms
		Rotational Speed	15,000 rpm	
		Logical Blocks	1,172,123,568 - 512 b	yte blocks
		Operating Temperature	e 50° to 95° F (10° to 35	ο° C)
	450GB SAS 15K rpm	Capacity	450GB	
	6Gb/s 3.5" HDD	Height	1 in; 2.54 cm	
		Width	Media Diameter	3.5 in; 8.9 cm
			Physical Size	4 in; 10.17 cm
		Interface	SAS	
		Synchronous Transfer Rate (Maximum)	6Gb/s	
		Buffer	16MB	
		Seek Time (typical reads, includes controller overhead, including settling)	Single Track	0.2 ms
			Average	3.4 ms
			Full Stroke	6.6 ms
		Rotational Speed	15,000 rpm	
		Operating Temperature 50° to 95° F (10° to 35° C)		
	300GB SAS 15K rpm 6Gb/s 3.5" HDD	Capacity	300GB	
		Height	1 in; 2.54 cm	
		Width	Media Diameter	3.5 in; 8.9 cm
			Physical Size	4 in; 10.17 cm
		Interface	SAS	
		Synchronous Transfer Rate (Maximum)	6Gb/s	
		Buffer	16MB	
		Seek Time (typical	Single Track	0.2 ms
		reads, includes controller overhead, including	Average	3.4 ms
		settling)	Full Stroke	6.6 ms
		Rotational Speed	15,000 rpm	
		Operating Temperature	e 50° to 95° F (10° to 35	ο° C)
		Canacity	20000	
	HP 300GB SAS 10K SFF HDD	Capacity	300GB	
		Height	0.6 in; 1.53 cm	

1					
		Width	Media Diameter	2.5 in; 6.36 cm	
			Physical Size	2.75 in; 6.99 cm	
		Interface	SAS 6Gb/s		
		Synchronous Transfer Up to 600MB/s Rate (Maximum)			
		Buffer	64MB		
		Cache	multi-segmentable cache buffer		
		Seek Time (typical	Single Track	0.4 ms (max)	
		reads, includes controller	Average	3.6 ms	
		overnead, including	Full Stroke	7.3 ms	
	settling) Rotational Speed Logical Blocks		10,000 rpm		
			585,937,500		
		Operating Temperature		° C)	
		Operating reinperature	41 10 131 F (5 10 55	0)	
	HP 600GB SAS 10K	Capacity	600GB		
	SFF HDD	Height	0.6 in; 1.53 cm		
		Width	Media Diameter	2.5 in; 6.36 cm	
			Physical Size	2.75 in; 6.99 cm	
		Interface	SAS 6Gb/s		
		Synchronous Transfer Up to 600MB/s Rate (Maximum)			
		Buffer	64MB		
		Cache	multi-segmentable cache buffer		
		Seek Time (typical reads, includes controller overhead, including settling)	Single Track	0.4 ms (max)	
			Average	3.6 ms	
			Full Stroke	7.3 ms	
		Rotational Speed	10,000 rpm		
		Logical Blocks	1,172,123,568		
		Operating Temperature41° to 131° F (5° to 55° C)			
	HP 900GB SAS 10K	Capacity	900GB		
	SFF HDD	Height	0.6 in; 1.53 cm		
		Width	Media Diameter	2.5 in; 6.36 cm	
			Physical Size	2.75 in; 6.99 cm	
		Interface	SAS 6Gb/s Up to 600MB/s		
		Synchronous Transfer Rate (Maximum)			
		Buffer	64MB		
		Cache	multi-segmentable cacl	ne buffer	
		Seek Time (typical	Single Track	0.2ms (max)	
		reads, includes controller	Average	3.5ms	
		overhead, including settling)	Full Stroke	7.0ms	
		Rotational Speed	10,000 rpm		
		Logical Blocks	1,758,174,767		
		Operating Temperature41° to 131° F (5° to 55° C)			

Technical Specifications - Hard Drives

	HP 1.2TB SAS 10K SFF HDD	Capacity Height Width Interface Synchronous Transfer Rate (Maximum) Buffer Seek Time (typical reads, includes controller overhead, including settling) Rotational Speed Logical Blocks	1.2TB 0.6 in; 1.53 cm Media Diameter Physical Size SAS 6Gb/s Up to 600MB/s 64MB Single Track Average Full Stroke 10,000 rpm 2,344,225,968	2.5 in; 6.36 cm 2.75 in; 6.99 cm 0.18ms (max) 3.5ms 7.17ms
		Operating Temperature	e41° to 131° F (5° to 55°	° C)
SATA (Serial ATA) Har Drives for HP Workstations	d250GB SATA 10K rpm SFF HDD	Capacity Height Width	250GB 0.6 in; 1.53 cm Media Diameter	2.5 in; 6.36 cm
			Physical Size	2.75 in; 6.99 cm
		Interface Synchronous Transfer Rate (Maximum)	Serial ATA (6Gb/s) Up to 600MB/s	
		Buffer	64MB	
		Cache	Adaptive	
		Seek Time (typical reads, includes controller overhead, including settling)	Single Track Average Full Stroke	1.2ms (typical) 3.6ms 9.0ms (typical)
		Rotational Speed	10K rpm	
		Operating Temperature	e41° to 131° F (5° to 55°	° C)
	500GB SATA 10K rpm SFF HDD	Capacity Height	500GB 0.6 in; 1.53 cm	
		Width	Media Diameter Physical Size	2.5 in; 6.36 cm 2.75 in; 6.99 cm
		Interface Synchronous Transfer Rate (Maximum)	Serial ATA (6Gb/s) Up to 600MB/s	
		Buffer	64MB	
		Cache	Adaptive	
		Seek Time (typical reads, includes controller overhead, including settling)	Single Track Average Full Stroke	 1.2ms (typical) 3.6ms 9.0ms (typical)
		Rotational Speed	10K rpm	
		Operating Temperature	•	° C)

Technical Specifications - Hard Drives

1TB SATA 10K rpm	Capacity	1TB	
SFF HDD			
	Height Width	0.6 in; 1.53 cm Media Diameter	2.5 in; 6.36 cm
	widin	Physical Size	2.75 in; 6.99 cm
	Interface	-	2.75 III, 0.99 CIII
		Serial ATA (6Gb/s)	
	Synchronous Transfer Rate (Maximum)	Up to 600 MB/s	
	Buffer	64MB	
	Cache	Adaptive	
	Seek Time (typical	Single Track	1.2ms (typical)
	reads, includes controller overhead, including	Average	3.6ms
	settling)	Full Stroke	9.0ms (typical)
	Rotational Speed	10K rpm	
	Operating Temperature	•	°C)
	J		- /
500GB SATA 7200 rpm	Capacity	500GB	
6Gb/s 3.5" HDD	Height	0.6 in; 1.53 cm	
	Width	Media Diameter	3.5 in; 8.9 cm
		Physical Size	4 in; 10.17 cm
	Interface	Serial ATA (6.0Gb/s), I	NCQ enabled
	Synchronous Transfer Rate (Maximum)	Up to 600MB/s	
	Buffer	16MB	
	Cache	Segmentable	
	Seek Time (typical	Single Track	2 ms
	reads, includes controller	Average	11 ms
	overhead, including settling)	Full-Stroke	21 ms
	Rotational Speed	7,200 rpm	
	Logical Blocks	976,773,168	
	Operating Temperature	e41° to 131° F (5° to 55	°C)
1TB SATA 7200 rpm	Capacity	1 Terabyte (1000 GB)	
6Gb/s 3.5" HDD	Height	1 in; 2.54 cm	
	Width	Media Diameter	3.5 in; 8.9 cm
		Physical Size	4 in; 10.17 cm
	Interface	Serial ATA (6.0Gb/s), I	NCQ enabled
	Synchronous Transfer Rate (Maximum)	Up to 600 MB/s	
	Cache	32 MB	
	Seek Time (typical	Single Track	2 ms
	reads, includes controller	Average	11 ms
	overhead, including settling)	Full-Stroke	21 ms
	Rotational Speed	7,200 rpm	
	Logical Blocks	1,953,525,168	
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Technical Specifications - Hard Drives

2.0TB SATA 7200 rpm	Capacity	2TB	
6Gb/s 3.5" HDD	Height	1 in; 2.54 cm	
	Width	Media Diameter	3.5 in; 8.9 cm
		Physical Size	4 in; 10.17 cm
	Interface	Serial ATA (6.0 Gb/s),	NCQ Enabled
	Synchronous Transfer	Up to 600 MB/s	
	Rate (Maximum)		
	Cache	64MB	
	Seek Time (typical	Single Track	2 ms
	reads, includes controller	Average	11 ms
	overhead, including settling)	Full-Stroke	21 ms
	Rotational Speed	7,200 rpm	
	Logical Blocks	3,907,029,168	
	Operating Temperature		°C)
	- p		-)
3.0TB SATA 7200 rpm	Capacity	3.0TB	
6Gb/s 3.5" HDD	Height	1 in; 2.54 cm	
	Width	Media Diameter	3.5 in; 8.9 cm
		Physical Size	4 in; 10.17 cm
	Interface	Serial ATA (6.0Gb/s), N	NCQ enabled
	Synchronous Transfer Rate (Maximum)	Up to 6.0 Gb/s	
	Buffer	64MB	
	Seek Time (typical	Single Track	0.6 ms
	reads, includes controller	Average	11 ms
	overhead, including settling)	Full-Stroke	Not specified
	Rotational Speed	7200 rpm	·
	Operating Temperature		°C)
	J		- /
500GB SATA 7.2K SED	Capacity	500GB	
SFF HDD	Height	0.275 in; 0.7 cm	
	Width	Media Diameter	2.5 in; 6.36 cm
		Physical Size	2.75 in; 6.99 cm
	Interface	Serial ATA (6Gb/s)	
	Synchronous Transfer Rate (Maximum)	Up to 600MB/s	
	Buffer	32MB	
	Seek Time (typical	Single Track	1 ms
	reads, includes controller	Average	4.2 ms
	overhead, including settling)	Full-Stroke	25 ms (typical)
	Rotational Speed	7,200 rpm	
	Operating Temperature	•	°C)
			- /



Technical Specificat	ions - Hard Drives			
HP Solid State Drives	HP 128GB SATA 6Gb/s	Capacity	128GB	
(SSDs) for	SSD	Height	0.28 in; 0.7 cm	
Workstations		Width	Physical Size	2.5 in; 6.36 cm
		Interface	SATA 6Gb/s	
		Synchronous Transfer Rate (Maximum)	Up to 500MB/s (Seque	ential Read)
		Operating Temperatur	e 32° to 158° F (0° to 70	°C)
	HP 256GB SATA 6Gb/s	Capacity	256GB	
	SSD	Height	0.28 in; 0.7 cm	
		Interface	SATA 6Gb/s	
		Synchronous Transfer Rate (Maximum)	Up to 500MB/s (Seque	ential Read)
		Operating Temperatur	e 32° to 158° F (0° to 70	°C)
	HP 256GB SATA 6Gb/s	Capacity	256GB	
	SED SSD	Height	0.28 in; 0.7 cm	
		Width	Physical Size	2.5 in; 6.36 cm
		Interface	6Gb/s SATA	
		Synchronous Transfer Rate (Maximum)	Up to 500MB/s (Seque	ential Read)
		Operating Temperatur	e 32° to 158° F (0° to 70	°C)
	HP 512GB SATA 6Gb/s	Capacity	512GB	
	SSD	Height	0.28 in; 0.7 cm	
		Width	Physical Size	2.5 in; 6.36 cm
		Interface	6Gb/s SATA	
		Synchronous Transfer Rate (Maximum)	Up to 500MB/s (Seque	ential Read)
		Operating Temperatur	e 32° to 158° F (0° to 70	°C)
	Intel Pro 1500 180GB	Capacity	180GB	
	SATA SSD	Width	Physical Size	2.5 in; 6.36 cm
		Interface	6Gb/s SATA	
		Synchronous Transfer Rate (Maximum)	600 Mb/s	
	Samsung SM843T	Capacity	240GB	
	240GB SATA SSD	Width	Physical Size	2.5 in; 6.36 cm
		Interface	SATA 6Gb/s	
		Synchronous Transfer Rate (Maximum)	Up to 600MB/s	
		Operating Temperatur	e 32° to 158° F (0° to 70	°C)

Technical Specifications - Hard Drives

	Samsung SM843T 480GB SATA SSD	Capacity Width Interface Synchronous Transfer Rate (Maximum) Operating Temperatur		2.5 in; 6.36 cm 0° C)
PCIe SSDs for HP Workstations	HP Z Turbo Drive 256GB SSD	Capacity Interface Operating Temperatur	256GB PCI Express 2.0 x4 e re32° to 158° F (0° to 7	
	HP Z Turbo Drive 512GB SSD	Capacity Interface Operating Temperatur	512GB PCI Express 2.0 x4 e re32° to 158° F (0° to 7	
	Fusion ioFX 410GB PCIe Accelerator	Capacity Interface Operating Temperatur	410GB PCI Express 2.0 x4 e re32° to 95° F (0° to 35	



Technical Specifications - Hard Drive Controllers

LSI 9217-4i4e 8-port	PCI Bus	8 lanes, PCI Express 3.0	
SAS 6Gb/s RAID Card	RAID Levels	Offers Integrated RAID (0, 1, 1E and	d 10)
	PCI Data Burst Transfer Rate	Half Duplex x8, PCIe, 8000 MB/s	
	SAS Bandwidth	Half Duplex	600 MB/s per lane
	PCI Card Type	3.3V Add-in Card	
	PCI Voltage	12 V ± 10%	
	PCI Power	9.8W typical, Airflow min 200 LFM	
	Bracket	Full height and low profile	
	Certification Level	PCI Express 3.0 compliant	
	SAS Processor	LSI SAS2308/ Fusion MPT 2.0	
	Internal Connectors	One x4 internal mini-SAS (SFF808)	7)
	External Connectors	One x4 external mini-SAS (SFF808	88)
	Maximum Number of SCSI Devices	256 Non-RAID SAS/SATA devices	
	LED Indicators	N/A	
LSI 9270-8i SAS 6Gb/s	PCI Bus	x8 lane PCIe 3.0 compliant	
ROC RAID Card and iBBU9 Battery Backup	RAID Levels	RAID 0, 1, 5, and 6 RAID spans 10, 50 and 60	
Unit	PCI Card Type	Low profile, single PCIe slot design	with full height bracket.
	PCI Voltage	+3.3V Add-in Card	
	PCI Power	+3.3V, +12V	
	Certification Level	PCI-Express 3.0	
	IO Bus	Eight 6Gb/s and 3Gb/s compatible	SAS/SATA ports
	SAS Processor	LSISAS2208 Dual-Core RAID on Ch	nip (ROC)
	Internal Connectors	Two SAS SFF8087 x4 (Mini-SAS)	
	External Connectors	None	
	Maximum Number of SCSI Devices	Up to 128 SAS and/or SATA hard d NOTE: HP Workstations do not sup	
	LED Indicators	Heartbeat LED on card	



NVIDIA NVS 310 512ME Graphics	B Form Factor	Low Profile: 2.713 inches in height × 6.150 inches in length Weight: ~142 grams
	Graphics Controller	NVIDIA NVS 310 GPU: GF119-825
	Bus Type	PCI Express x16, 2.0 compliant
	Memory	Size: 512MB DDR3 Clock: 875Mhz Memory Bandwidth: 14GB/s
	Connectors	2 x DisplayPort
	Maximum Resolution	Up to 2560 x 1600 (digital display) per display.
	Image Quality Features	 The following video formats are supported: MPEG2 MPEG4 Part 2 Advanced Simple Profile H.264 SVC codec support Support for 3D Blu Ray VC1 DivX version 3.11 and later MVC
		A full range of video resolutions are supported including 1080p, 1080i, 720p, 480p and 480i. The NVS 310 GPU provides hardware acceleration for the computationally intensive parts of video processing, as well as provides improved video playback speeds via faster decode and transcode.
	Display Output	Up to 2 displays in the following configurations:
		DisplayPort output:
		 Drives two DisplayPort enabled digital display at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking, when connected natively using the 2 DisplayPort connectors on the NVS 310 graphics card Supports 2 monitors up to resolution of 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort 1.2 multi stream topology technology.
		DVI-D output:
		 Drives two digital display at resolutions up to 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort to DVI-D single-link cable adaptors Drives two digital display at resolutions up to 2560× 1600 at 60 Hz with reduced blanking using DisplayPort to DVI-D dual-link cable adaptors
		HDMI output:
		 NVS 310 is capable of driving two high definition (HD) panels up to resolutions of 1920 × 1080P at 60 Hz using DisplayPort to HDMI cable adaptors
		VGA display output:
		 Drives two analog display at resolutions up to 1920 × 1200 at 60 Hz using DisplayPort to VGA cable adaptors

	Shading Architecture Supported Graphics APIs Available Graphics Drivers	Shader Model 5.0 DX11, OpenGL 4.1 Windows 8 Genuine Windows 7 Professional (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit) HP qualified drivers may be preloaded or the latest HP qualified drivers
	Power Consumption Note	 are available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com 19.5 Watts 1. The thermal solution used on this card is an active fan heatsink. 2. Factory configured NVS 310 graphics card have no cable adpaters included. Adapters must be ordered separately. 3. Option kit NVS 310 includes 2 DP to DVI-D cable adapters.
NVIDIA NVS 315 1GB Graphics (for HP Workstations)	Form Factor	Low Profile: 2.713 inches in height × 5.7 inches in length Weight: ~142 grams
	Graphics Controller	NVIDIA NVS 315 (using GF119-825 GPU) Number of Cores: 48 CUDA cores Max. Power: 19.3W Cooling Solution: Active fan heatsink
	Bus Type	PCI Express x16, 2.0 compliant
	Memory	Size: 1GB DDR3 Clock: 875Mhz Memory Bandwidth: 14GB/s
	Connectors	DMS-59 output Cables included: - For CTO: DMS-59 to DVI cable - For AMO: DMS-59 to DVI cable and DMS-59 to VGA cable
	Maximum Resolution	Maximum number of displays supported: 2
		Maximum Resolution Support: - DMS-59 to VGA: 2048 x 1536 @ 85Hz - DMS-59 to DVI: 1980 x 1200 @ 60Hz - DMS-59 to DP: 2560 x 1600 @ 60Hz
	Image Quality Feature	s See Display Output section.
		The following video formats are supported: - MPEG2 - MPEG4 Part 2 Advanced Simple Profile - H.264 SVC codec support - Support for 3D Blu Ray - VC1 - DivX version 3.11 or later A full range of video resolutions are supported including 1080p, 1080i, 720p, 480p and 480i. The NVS 315 GPU provides hardware

	Display Output	acceleration for the computationally intensive parts of video processing, as well as provides improved video playback speeds via faster decode and transcode. Up to 2 displays using one of the following DMS-59 cables: DMS-59 to DVI DMS-59 to VGA DMS-59 to DP
		DisplayPort output: - Drives two DisplayPort enabled digital displays at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking, when connected via the DMS-59 to DP adapter.
		DVI-D output: - Drives two digital display at resolutions up to 1920 × 1200 at 60 Hz with reduced blanking using DMS-59 to DVI-D single-link cable adaptor
		VGA display output: - Drives two analog display at resolutions up to 2048 × 1536 at 85 Hz using DMS-59 to VGA cable adaptor.
	Shading Architecture	Shader Model 5.0
	Supported Graphics APIs	DX11, OpenGL 4.3
	Available Graphics Drivers	Windows 8 Microsoft Windows 7 Professional (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)
		HP qualified drivers may be preloaded or the latest HP qualified drivers are available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
		SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com
	Notes	 The thermal solution used on this card is an active fan heatsink. Factory configured graphics card includes DMS-59 to DVI cable. Option kit graphics card includes DMS-59 to DVI and DMS-59 to VGA cables (one each).
NVIDIA NVS 510 2GB Graphics	Form Factor Graphics Controller	Low Profile, 2.713 inches × 6.3 inches, single slot NVS 510 GPU Core Clock: 797 Mhz Memory Clock: 891 Mhz CUDA Cores: 192
	Bus Type	PCI Express x16, Generation 2.0
	Memory	2GB DDR3
	Connectors	Four mini-DisplayPort.
		Four mini-DisplayPort to DisplayPort adapters included. (DisplayPort to DVI-D, DisplayPort to VGA, DisplayPort to HDMI, and DisplayPort to Dual-Link DVI adapters available as separate accessories)



Technical Specifications - Graphics Maximum Resolution Mini-DisplayPort connectors support ultra-high-resolution panels (up to 3840 x 2160 @ 60Hz) **NOTE:** This card supports up to four displays. For Windows XP, only 2 active displays are supported. Image Quality Features 10-bit internal display processing, including hardware support for 10-bit scan-out **Display Output** DisplayPort with Multi-Stream Technology (MST) and High Bit Rate 2 (HBR2) support. **Digital Display Support** 1. DisplayPort Output - Drives four DisplayPort enabled digital display at resolutions up to 3840 × 2160 at 60 Hz with reduced blanking, when connected natively using the 4 DisplayPort connectors on the NVS 510 graphics card. - DisplayPort Multi-Stream Topology (MST) Technology: Supports various combinations of display resolutions and number of displays when using DisplayPort multi stream topology technology - up to a maximum of 4 monitors at a resolution of 1920 × 1200 at 60 Hz with reduced blanking. 2. DVI-D Output - Drives four digital displays at resolutions up to 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort to DVI-D single-link cable adaptors. - Drives four digital displays at resolutions up to 2560× 1600 at 60 Hz with reduced blanking using DisplayPort to DVI-D dual-link cable adaptors. 3. HDMI Output - The NVS 510 graphics board is capable of driving four high definition (HD) panels up to resolutions of 1920 × 1080P at 60 Hz using DisplayPort to HDMI cable adaptors. Analog Display Support 1. VGA display output - Drives four analog displays at resolutions up to 1920 × 1200 at 60 Hz using DisplayPort to VGA cable adaptors. Supported Graphics Full Microsoft DirectX 11, Shader Model 5.0 support **APIs** Full OpenGL 4.3 support **Available Graphics** Genuine Windows 7 Professional (64-bit and 32-bit) **Drivers** Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit) HP gualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html **Power Consumption** 33.4 Watts

 Note
 Heatsink cooler design is active.



Technical Specifications - Graphics			
Graphics Cable Adapters	Note	Graphics Cable Adapter option choice is available starting Feb 1 2013 for the following graphics cards: NVS 310, Quadro 410, Qaudro K5000, FirePro V3900, FirePro W7000	
		New Graphics Cards introduced after Feb 1 2013 will be eligible for choosing Graphics Cable Adapters, unless otherwise specified.	
		No cable choice for NVS 300, NVS 510.	
		Maximum number of cables allowed is 8.	
NVIDIA Quadro 410 512MB Graphics	Form Factor	Low Profile: 2.713 inches × 5.7 inches, single slot	
	Graphics Controller	NVIDIA Quadro 410 GPU: GK107	
	Bus Type	PCI Express x16, 3.0 compliant	
	Memory	Size: 512MB DDR3 Clock: 900MHz Memory Bandwidth: 14GB/s	
	Connectors	One dual-link DVI-I connector One DisplayPort connector	
	Maximum Resolution	VGA (through DVI to VGA cable):	
		• 2048 × 1536 × 32 bpp at 85 Hz	
		Dual-link DVI	
		• 2560 × 1600 × 32 bpp at 60 Hz (reduced blanking)	
		Single-link DVI	
		• 1920 × 1200 × 32 bpp at 60 Hz (reduced blanking)	
		DisplayPort 1.2	
		 3840 × 2160 × 36 bpp at 60 Hz 	
	RAMDAC	400 MHz integrated RAMDAC	
	Display Output	Maximum number of displays supported: 2	
	Shading Architecture	Shader Model 5.0	
	Supported Graphics APIs	DX11, OpenGL 4.2	
	Available Graphics Drivers	Windows 8 Genuine Windows 7 Professional (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)	
		HP qualified drivers may be preloaded or the latest HP qualified drivers are available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html	
		SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com	

	Notes	 Factory configured Quadro 410 does not include any video adapters. Adapters must be ordered separately. Option kit Quadro 410 includes one DP to DVI-D adapter
NVIDIA Quadro K600 1GB Graphics	Form Factor	2.731" H x 6.3" L Single Slot, Low Profile Full Height Profile bracket installed Low Profile bracket included
	Graphics Controller	NVIDIA Quadro K600 Graphics Card Kepler GK107 GPU 192 CUDA cores Max Power: 41 Watts
	Bus Type	PCI Express 2.0 x16
	Memory	1 GB GDDR3, 891 Mhz 128-bit memory I/O path 29 GB/s memory bandwidth
	Connectors	1 DL-DVI(I) output, 1 DisplayPort output CTO: No video cable adapter included AMO: One DP-to-DVI adapter included with card
		Additional DVI-to-VGA, DisplayPort-to-VGA or DisplayPort-to-DVI adapters are available as accessories
	Maximum Resolution	DisplayPort: - up to 3840 x 2160 x 30 bpp @ 60Hz - supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)
		DL-DVI(I) output: - up to 2560 x 1600 x 32 bpp @ 60Hz
	Image Quality Feature	 s 10-bit internal display processing pipeline 10-bit scan-out support
	Display Output	VGA: - requires use of DVI-to-VGA and/or DP-to-VGA video cable adapters - 400 Mhz integrated RAMDAC - Max resolution: 2048 x 1536 x 32 bpp @ 85 Hz
		DL-DVI(I): - Max resolution: 2560 x 1600 x 32 bpp @ 60 Hz
		SL-DVI(I): - Max resolution: 1920 x 1200 x 32 bpp @ 60 Hz
		DisplayPort: - Supports HBR2 and MST - Max resolution: 3840 x 2160 x 30 bpp @ 60 Hz (only one monitor can be connected to the Quadro K600 DisplayPort connector at this resolution) - Max number of daisy-chained monitors: 2
	Shading Architecture	Full Microsoft DirectX 11 Shader Model 5.0
	Supported Graphics	OpenGL 4.3
	APIs	DirectX 11
		API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran
	Available Graphics Drivers	Windows 8 Pro 64-bit Windows 8 (China) 64-bit

Technical Specifica	tions - Graphics	
		Genuine Windows 7 Professional (64-bit and 32-bit)
		Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit) Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit)
		HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
		SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com
	Notes	 Quadro K600 offered as CTO does not include a video cable adapter. Video cable adapters must be ordered separately. Quadro K600 offered as AMO includes one DP-to-DVI video cable adapter. Additonal cables must be ordered separately. Quadro K600 is Windows 8 Compliant. A total maximum of 2 active monitors are supported across all display output types.
AMD FirePro V3900	Form Factor	Full height, half length (full-height bracket included)
1GB Graphics	Graphics Controller	AMD FirePro™ V3900 professional graphics
	Bus Type	PCI Express® x16, Generation 2.1
	Memory	1GB DDR3 memory
	Connectors	1 DL DVI, 1 DP output One DP to DVI adapter included
	Maximum Resolution	2560x1600 per display (5120x1600 max. horizontal resolution)
	Display Output	1 DisplayPort® 1.2 1 Dual-link DVI
	Supported Graphics APIs	OpenCL™ 1.1, DirectX® 11 and OpenGL 4.2
	Available Graphics Drivers	Genuine Windows® 7 Professional (64-bit and 32-bit) Genuine Windows Vista® Business (64-bit and 32-bit) Microsoft® Windows XP® Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)
		HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
	Power Consumption	<50W
	Note	AMD Eyefinity technology can support multiple displays using a single enabled AMD FirePro [™] professional graphics card; the number of supported displays varies by card model. Microsoft® Windows® 7, Windows Vista®, or Linux® is required in order to support more than 2 displays. Depending on the card model, native DisplayPort [™] connectors and/or certified DisplayPort [™] active or passive adapters to convert your monitor's native input to your card's DisplayPort [™] or Mini-DisplayPort [™] connector(s) may be required. See www.amd.com/firepro for details.
NVIDIA Quadro K2000 2GB Graphics	Form Factor	4.38" H x 7.97" L Single Slot, Full Height

Graphics Controller	NVIDIA Quadro K2000 Graphics Card Kepler GK107 GPU 384 CUDA cores Max Power: 51.1 Watts	
Bus Type Memory	PCI Express 2.0 x16 2 GB GDDR5, 2000 Mhz 128-bit memory I/O path 64 GB/s memory bandwidth	
Connectors	1 DL-DVI(I) output, 2 DisplayPort outputs CTO: No video cable adapter included AMO: One DP-to-DVI adapter included with card	
Maximum Resolution	Additional DVI-to-VGA, DisplayPort-to-VGA or DisplayPort-to-DVI adapters are available as accessories DisplayPort: - up to 3840 x 2160 x 30 bpp @ 60Hz - supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)	
Image Quality Feature		
Display Output	 10-bit scan-out support VGA: requires use of DVI-to-VGA and/or DP-to-VGA video cable adapters 400 Mhz integrated RAMDAC Max resolution: 2048 x 1536 x 32 bpp @ 85 Hz 	
	DL-DVI(I): - Max resolution: 2560 x 1600 x 32 bpp @ 60 Hz	
	SL-DVI(I): - Max resolution: 1920 x 1200 x 32 bpp @ 60 Hz	
	DisplayPort: - Supports HBR2 and MST - Max resolution: 3840 x 2160 x 30 bpp @ 60 Hz (only one monitor can be connected to a Quadro K2000 DisplayPort connector at this resolution) - Max number of DisplayPort daisy-chained monitors or hub connected monitors from a single Quadro K2000 DisplayPort connector: 4 with maximum resolution of 1920 x 1200	
	Maximum number of monitors across all available Quadro K2000 outputs is 4.	
Shading Architecture	Full Microsoft DirectX 11 Shader Model 5	
Supported Graphics APIs	OpenGL 4.3 DirectX 11 API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran	
Available Graphics Drivers	Windows 8 Pro 64-bit Windows 8 (China) 64-bit Genuine Windows 7 Professional (64-bit and 32-bit)	
	Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit) Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation	



Technical Specifications - Graphics			
		SUSE Linux Enterprise Desktop 11 (64-bit)	
		HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html	
	Notes	 SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com 1. Quadro K2000 offered as CTO does not include a video cable adapter. Video cable adapters must be ordered separately. 2. Quadro K2000 offered as AMO includes one DP-to-DVI video cable adapter. Additional cables must be ordered separately. 	
NVIDIA Quadro K4000 3GB Graphics	Form Factor	4.376" H x 9.5" L Single Slot, Full Height	
	Graphics Controller	NVIDIA Quadro K4000 Graphics Card Kepler GK106 GPU 768 CUDA cores Max Power: 80 Watts	
	Bus Type	PCI Express 2.0 x16	
	Memory	3 GB GDDR5, 2800 Mhz 192-bit memory I/O path 134 GB/s memory bandwidth	
	Connectors	1 DL-DVI(I) output, 2 DisplayPort outputs CTO: No video cable adapter included AMO: One DP-to-DVI adapter included with card	
		Additional DVI-to-VGA, DisplayPort-to-VGA or DisplayPort-to-DVI adapters are available as accessories	
	Maximum Resolution	DisplayPort: - up to 3840 x 2160 x 30 bpp @ 60Hz - supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)	
		DL-DVI(I) output: - up to 2560 x 1600 x 32 bpp @ 60Hz	
	Image Quality Feature	 s • 10-bit internal display processing pipeline • 10-bit scan-out support 	
	Display Output	VGA: - requires use of DVI-to-VGA and/or DP-to-VGA video cable adapters - 400 Mhz integrated RAMDAC - Max resolution: 2048 x 1536 x 32 bpp @ 85 Hz	
		DL-DVI(I): - Max resolution: 2560 x 1600 x 32 bpp @ 60 Hz	
		SL-DVI(I): - Max resolution: 1920 x 1200 x 32 bpp @ 60 Hz	
		DisplayPort: - Supports HBR2 and MST - Max resolution: 3840 x 2160 x 30 bpp @ 60 Hz (only one monitor can be connected to a Quadro K4000 DisplayPort connector at this resolution) - Max number of DisplayPort daisy-chained monitors or hub connected monitors from a single Quadro K4000 DisplayPort connector: 4 with maximum resolution of 1920 x 1200	

	HDMI: - Requires use of DP-to-HDMI cable - Max Resolution: 1920 x 1080 x 32 bpp @ 60Hz		
	Maximum number of monitors across all available Quadro K4000 outputs is 4.		
Shading Architecture	Full Microsoft DirectX 11 Shader Model 5.0		
Supported Graphics APIs	OpenGL 4.3 DirectX 11 API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran		
Available Graphics Drivers	Windows 8 Pro 64-bit Windows 8 (China) 64-bit Genuine Windows 7 Professional (64-bit and 32-bit)		
	Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit) Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit)		
	HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html		
	SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com		
Notes	 Quadro K4000 offered as CTO does not include a video cable adapter. Video cable adapters must be ordered separately. 		
	 Quadro K4000 offered as AMO includes one DP-to-DVI video cable adapter. Additional cables must be ordered separately. Quadro K4000 is Windows 8 Compliant. A total maximum of 4 active monitors are supported across all 		
	 display output types. To get 4 monitors, at least one monitor must be daisy chained on a DisplayPort output. 5. A DisplayPort hub device may be used to connect multiple DisplayPort monitors to a single Quadro K4000 DisplayPort output. 		



	Note	No display output adapter included.
	Power Consumption	http://welcome.hp.com/country/us/en/support.html 122 Watts
		HP qualified drivers may be preloaded or available from the HP support Web site:
		Red Hat Enterprise Linux (RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)
		Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit and 32- bit)
	Drivers	Genuine Windows Vista Business (64-bit and 32-bit)
	Available Graphics	OpenCL, Java, Python, Fortran Genuine Windows 7 Professional (64-bit and 32-bit)
	Supported Graphics APIs	OpenGL 4.2 DirectX 11 Shader model 5.0 Support API support for NVIDIA's CUDA™ C, CUDA C++, DirectCompute 5.0,
	Supported Overhies	Maximum resolution: 1920 × 1080 × 32 bpp at 60Hz
		HDMI
		• Maximum resolution: 3840 × 2160 × 36 bpp at 60Hz
		DisplayPort with MST and HBR2.
		 Maximum resolution over digital port (single GPU and SLI mode):1920 × 1200 × 32 bpp at 60 Hz (reduced blanking)
		Single-link internal TMDS (DVI 1.0)
		 Maximum resolution over digital port (single GPU and SLI mode): 2560 × 1600 × 32 bpp at 60 Hz (reduced blanking)
		Dual-link internal TMDS (DVI 1.0)
		× 1536 × 32 bpp at 85 Hz
		 Maximum resolution over VGA (through DVI to VGA cable): 2048
	Display Output	 NVIDIA 3D Vision™ technology 400 MHz integrated RAMDAC
	Image Quality Features	Rate 2 (HBR2), HDMI 1.4, and HDCP support
		DVI to VGA, DisplayPort to VGA, DisplayPort to DVI, and DisplayPort to Dual-Link DVI adapters available as accessories
		DIN connector. No adapter included with card.
	Connectors	DVI-I (1), DVI-D (1), DP (2), Optional 3D Stereo bracket with 3-pin mini-
	Memory	4GB GDDR5 173GB/s memory bandwidth
	Bus Type	PCI Express 2.0 x16
40b Graphics	Graphics Controller	NVIDIA Quadro K5000 Graphics Card based on the GK104 GPU
4GB Graphics	Form Factor	4.376" H x 10.5" L Dual Slot



Technical Specifications - Graphics

AMD FirePro W7000	Form Factor	Full beight full longth single slot
4GB Graphics		Full height, full length, single slot AMD FirePro™ W7000 Professional Graphics
	Graphics Controller	Max Power: <150 Watts
	Bus Type	PCI Express™ x16, Generation 3.0
	Memory	4GB GDDR5, 153.6 GB/s bandwidth, ECC support
	Connectors	4 x DisplayPort with HBR2 and MST support.
	Maximum Resolution	DisplayPort: 4096x2160 @24bpp 60Hz
		Dual Link DVI: 2560x1600 (requires DP to DL-DVI adapter) Single Link DVI: 1920x1200 (requires DP to DVI adapter) VGA: 1920x1200 (requires DP to VGA adapter)
	Image Quality Feature	SAdvanced support for 8-bit, 10-bit, and 16-bit per RGB color component
	Display Output	Max number of monitors supported using DisplayPort: 6
		Monitor chaining from a single DisplayPort options(subject to a max of 6 total monitors across all outputs, requires use of DisplayPort Monitors supporting MST or the use of DisplayPort hubs):
		 1 4096x2169 display 2 2560x1600 displays 4 1920x1200 displays
	Shading Architecture	Shader Model 5.0
	Supported Graphics APIs	OpenGL® 4.2 with OpenGL Shading Language OpenCL 1.1 Microsoft® DirectX® 11.1
	Available Graphics Drivers	Windows 8 Windows 7 Professional (64-bit and 32-bit) Windows 8 (64bit and 32-bit) Red Hat Enterprise Linux(RHEL) SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)
		HP qualified drivers may be preloaded or available from the HP support Web site:
	Nata	http://welcome.hp.com/country/us/en/support.html
	Note	1. AMD Eyefinity technology can support multiple displays using a single enabled AMD FirePro [™] professional graphics card; the number of supported displays varies by card model. Microsoft® Windows® 7, Windows Vista®, or Linux® is required in order to support more than 2 displays. Depending on the card model, native DisplayPort [™] connectors and/or certified DisplayPort [™] active or passive adapters to convert your monitor's native input to your card's DisplayPort [™] or Mini-DisplayPort [™] connector(s) may be required. See www.amd.com/firepro for details.
		2. Factory configured FirePro W7000 graphics card does not include any video adapter cables. Adapters must be ordered separately.
		3. Option Kit FirePro W7000 graphics card does not include any video cable adapters. Adapters must be ordered seperately.
NVIDIA Quadro K6000 12GB Graphics	Form Factor	4.376" H x 10.5" L Dual Slot Power: 234 Watts Weight: ~880 grams



Graphics Controller	NVIDIA Quadro K6000 Graphics Card based on the GK180 GPU Core Count: 2880 Base Clock: 797 MHz Boost Clock: 902 MHz	
Bus Type Memory	PCI Express 3.0 x16 12GB GDDR5 384-bit memory I/O path 288 GB/s memory bandwidth ECC Memory	
Connectors	DVI-I (1), DVI-D (1), DP (2), Optional 3D Stereo bracket with 3-pin mini- DIN connector.	
	Factory configured option: No adapter included with card. Option Kit: No adaptor included with card.	
	DVI to VGA, DisplayPort to VGA, DisplayPort to DVI, and DisplayPort to Dual-Link DVI adapters available as accessories.	
Maximum Resolution	Dual DisplayPort (up to 2560 x 1600 @ 60Hz and 1920x1200 @ 120Hz) Dual-link DVI-I output (up to 2560 x 1600 @ 60Hz and 1920x1200 @ 120Hz)	
Image Quality Feature	 DisplayPort with Multi-Stream Technology (MST) and High Bit Rate 2 (HBR2), HDMI 1.4, and HDCP support NVIDIA 3D Vision™ technology NVIDIA Premium Mosaic and nView 	
Display Output	400 MHz integrated RAMDAC	
	 Maximum resolution over VGA (through DVI to VGA cable): 2048 × 1536 × 32 bpp at 85 Hz 	
	Dual-link internal TMDS (DVI 1.0)	
	 Maximum resolution over digital port (single GPU and SLI mode): 2560 × 1600 × 32 bpp at 60 Hz (reduced blanking) 	
	Single-link internal TMDS (DVI 1.0)	
	 Maximum resolution over digital port (single GPU and SLI mode):1920 × 1200 × 32 bpp at 60 Hz (reduced blanking) 	
	DisplayPort with MST and HBR2.	
	 Maximum resolution: 3840 × 2160 × 36 bpp at 60Hz 	
	HDMI	
	 Maximum resolution: 1920 × 1080 × 32 bpp at 60Hz 	
Shading Architecture	Shader Model 5.0 Full IEEE 764-2008 32-bit and 64-bit precision	
Supported Graphics APIs	Full OpenGL 4.3 Full DirectX 11 CUDA API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran	
Available Graphics Drivers	Windows 8 Windows 7 Professional (64-bit and 32-bit) Red Hat Enterprise Linux (RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)	



Technical Specifications - Graphics

HP qualified drivers may be preloaded or available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Notes

 NVIDIA GRID VGX Pass Through feature supported on NVIDIA Quadro K6000 to enable direct mapping of GPU to Virtual Machine.
 No display output adapter included.



Technical Specifications - High Performance GPU Computing

NVIDIA Tesla K20c Compute Processor	Form Factor	4.376 inches by 10.5 inches Dual Slot		
	System Interface	PCI Express Gen2 ×16		
	Video Outputs	None.		
	Memory	5GB GDDR5, 320-bit memory path		
	Peak Memory Bandwidth	208 GB/s (with ECC off)		
	Supported APIs	CUDA and OpenACC API support includes: CUDA C, CUDA C++, Java, Python, and Fortran		
	Supported Operating Systems	Windows 8 (64-bit) Genuine Windows 7 Professional (64-bit) Red Hat Enterprise Linux (RHEL) 5, 6 Desktop/Workstation (64-bit) SUSE Linux Enterprise Desktop 11 (64-bit)		
		HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html		
		Novell SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com		
	Processor Cores	GK110 GPU, 706 MHz clock 2496 CUDA cores		
Power Consumption		~225 Watts		
		NOTE 1: A 1125W PSU is required for any K20 configuration on the Z820		
NVIDIA Tesla K40 Compute Processor	Form Factor	Size: 4.376 inches by 10.5 inches Slots: Dual Slot Power Connectors: One 6-pin and one 8-pin Weight: ~826 grams		
	System Interface	PCI Express Gen3 ×16		
	Video Outputs	None.		
	Memory	12GB GDDR5, memory path: 384-bit memory clock: 3Ghz		
	Peak Memory Bandwidth	288 GB/s		
	Supported APIs	CUDA, OpenACC, OpenCL 1.2 API support includes: C, C++, Java, Python, and Fortran		
	Supported Operating Systems	Windows 8 (64-bit) Genuine Windows 7 Professional (64-bit) Red Hat Enterprise Linux (RHEL) 5, 6 Desktop/Workstation (64-bit) SUSE Linux Enterprise Desktop 11 (64-bit)		
		HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html		
		Novell SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com		



Technical Specifications - High Performance GPU Computing

Processor Cores Power Consumption	GK110B GPU Base Clock: 745 MHz Boost Clock: up to 875 Mhz 2888 CUDA cores ~235 Watts
	Note 1 : A 1125W PSU is required for any K40 configuration on the Z820
Tesla K40 GPU Boost	By default the Tesla K40 active ships with the core clock set to the base clock. HPC workloads can have one or more characteristics as described. When selecting one of the supported boost clocks a good strategy is to characterize the workload with the available boost clocks. For example, DGEMM/Linpack are extremely demanding on power. Therefore, the "base clock" may be the correct choice when running Linpack. Some workloads in life sciences, manufacturing, CFD, CAD, etc., may have power headroom and can take advantage of one of the boost clocks.



Technical Specifications - Multimedia and Audio Devices

 HP Thin USB Powered
 Frequency Response (- FO to 20kHz

 Speakers
 3dB, 24-bit/96kHz input)

 Dimensions
 Speakers: 14.52 x 9.50 x 2.45 cm (5.72 x 3.74 x 0.96 in) per speaker

Technical Specifications - Optical and Removable Storage

HP DVD-ROM Drive	Description	5.25-inch, half-height, tray-load		
	Mounting Orientation	Either horizontal or vertical		
	Interface Type	SATA/ATAPI		
	Dimensions (WxHxD)	15.0 x 4.4 x 20.3 cm (5.	9 x 1.7 x 8.0 in)	
	Disc Capacity	DVD-ROM	Single layer: Up to 4.7 GB Double layer: Up to 8.5 GB	
	Access Times	DVD-ROM Single Layer < 140 ms (typical)		
		CD-ROM Mode 1	< 125 ms (typical)	
		Full Stroke DVD	< 250 ms (seek)	
		Full Stroke CD	< 210 ms (seek)	
	Power	Source	SATA DC power receptacle	
		DC Power	5 VDC ± 5%-100 mV ripple p-p	
		Requirements	12 VDC ± 5%-200 mV ripple p-p	
		DC Current	5 VDC - <1000 mA typical, < 1600 mA maximum 12 VDC - < 600 mA typical, < 1400 mA maximum	
	Operating	Temperature	41° to 122° F (5° to 50° C)	
	Environmental (all	Relative Humidity	10% to 90%	
	conditions non- condensing)	Maximum Wet Bulb Temperature	86° F (30° C)	
		Operating Systems Supported	Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP Home 32*. Red Hat Enterprise Linux(RHEL) WS4**, 5, 6 Desktop/Workstation, Removed reference to "Novell" because of acquisition and changed product reference to "SUSE Linux Enterprise Desktop 10 & 11", No driver is required for this device. Native support is provided by the operating system.	
HP DVD+/-RW Drive	Description	5.25-inch, half-height, tray-load		
	Mounting Orientation	Either horizontal or vertical		
	Interface Type	SATA/ATAPI		
	Dimensions (WxHxD)	$15.0 \times 4.4 \times 17.5 \text{ cm} (5.9 \times 1.7 \times 8.0 \text{ in})$		
	Disc Formats	DVD-RAM DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW		
	Disc Capacity	DVD-ROM	8.5 GB DL or 4.7 GB standard	
		Full Stroke DVD	< 240 ms (seek)	
		Full Stroke CD	< 200 ms (seek)	
			· · ·	



	Maximum Data Transfer Rates	CD ROM Read	CD-ROM, CD-R Up	to 40X
			CD-RW Up to 32X	1040
		DVD ROM Read	DVD-RAM	Up to 12X
			DVD+RW	Up to 8X
			DVD-RW	Up to 8X
			DVD+R DL	Up to 12X
			DVD-R DL	Up to 12X
			DVD-ROM	Up to 16X
			DVD-ROM DL	Up to 12X
			DVD+R	Up to 16X
			DVD-R	Up to 16X
	Power	Source	SATA DC power re	eceptacle
		DC Power Requirements	5 VDC ± 5%-100 n 12 VDC ± 5%-200	
		DC Current	maximum	typical, <1600 mA A typical, <2000 mA
	Operating	Temperature	41° to 122° F (5° to	o 50° C)
	Environmental (all	Relative Humidity	10% to 90%	
	conditions non- condensing)	Maximum Wet Bulb Temperature	86° F (30° C)	
		Operating Systems Supported	Professional 32-bit Windows Vista Bu Business 32*, Win 32*, Windows 2000 Professional or Win Red Hat Enterprise Desktop/Workstati	siness 64*, Windows Vista dows Vista Home Basic 0, Windows XP ndows XP Home 32*. e Linux(RHEL) WS4**, 5, 6
				d for this device. Native by the operating system.
		Kit Contents	Easy Media Creato	ulti DVD Writer Drive, Roxi or software, Intervideo installation guide, and
HP Blu-Ray Writer	Description	5.25-inch, half-height, tr	ay-load	
	Mounting Orientation	Either horizontal or vertical		
	Interface Type	SATA		
	Dimensions (WxHxD)) 15.0 x 4.4 x 20.3 cm (5.9 x 1.7 x 8.0 in) BD-ROM BD-R BD-RE DVD-RAM DVD+R DVD+RW		
	Disc Formats			

DVD-R DL DVD-R

Technical Specifications - Optical and Removable Storage

	DVD-RW CD-R			
Diao Canaaity	CD-RW DVD-ROM		atandard	
Disc Capacity		8.5 GB DL or 4.7 GB standard 50 GB DL or 25 GB standard		
	Blu-ray Full Stroke DVD			
	Full Stroke CD	< 250 ms (seek)		
		< 210 ms (seek)		
	Blu-ray	<275 ms (seek)	250 / 200	
	Startup Time (Time to drive ready from tray	BD-ROM (SL/DL)	25S / 28S	
	loading)	BD-R (SL/DL)	25S / 28S	
		BD-RE (SL/DL)	25S / 28S	
		DVD-ROM (SL/DL)	18S / 18S	
		DVD-R (SL/DL)	25S / 25S	
			25S	
		DVD+R (SL/DL)	25S / 25S	
		DVD+RW	25S	
		DVD-RAM CD-ROM	45S 45S	
Maximum Data	CD ROM Read	CD-ROM		
Transfer Rates		CD-ROM CD-R	Up to 40X Up to 40X	
		CD-RW	Up to 40X	
	DVD ROM Read	DVD-RAM	Up to 5X	
		DVD+RW	Up to 10X	
		DVD-RW	Up to 10X	
		DVD+R DL	Up to 8X	
		DVD-R DL	Up to 8X	
		DVD-ROM	Up to 16X	
		DVD-ROM DL	Up to 8X	
		DVD+R	Up to 12X	
		DVD-R	Up to 12X	
	Blu-Ray	BD-ROM	Up to 6X	
		BD-ROM DL	Up to 4.8X	
		BD-R	Up to 6X	
		BD-R DL	Up to 4.8X	
		BD-R	Up to 6X	
		BD-RE SL/DL	Up to 4.8X	
Power	Source	SATA DC power rece		
	DC Power Requirements	5 VDC ± 5%-100 mV ripple p-p 12 VDC ± 10%-100 mV ripple p-p		
	DC Current		al, 1200 mA maximum pical, 1600 mA maximum	
Operating	Temperature	41° to 122° F (5° to 50	0°C)	
Environmental (all	Relative Humidity	15% to 80%		
conditions non- condensing)	Maximum Wet Bulb Temperature	86° F (30° C)		
	Operating Systems Supported		nal 32-bit and 64-bit, ess 64*, Windows Vista ws Vista Home Basic	



Technical Specifications - Optical and Removable Storage			
			32*, Windows 2000, Windows XP Professional or Windows XP Home 32*. Red Hat Enterprise Linux(RHEL) WS4**, 5, 6 Desktop/Workstation, SUSE Linux Enterprise Desktop 10 & 11
			* No driver is required for this device. Native support is provided by the operating system.
			** RHEL WS4 not supported on Z200/Z200SFF
		Kit Contents	HP Blue Laser RW Drive, Roxio Easy Media Creator software, Intervideo WinDVD Software, installation guide.
	Disclaimer	digital connection, comp and do not constitute de systems is not guarante may require a DVI or HI	mat containing new technologies, certain disc, patibility and/or performance issues may arise, efects in the product. Flawless playback on all eed. In order for some Blu-Ray titles to play, they DMI digital connection and your display may HD-DVD movies cannot be played on this
HP DX115 Removable	Interface Type	Compatible with SAS or SATA controllers xHxL) 147.6 x 41.1 x 205 mm (5.81 x 1.62 x 8.08 in)	
Drive Enclosure	Dimensions (WxHxL)		
	Weight	Frame and Carrier: 1.73 Carrier: 0.45 kg (1 lbs)	kg (3.8 lbs)
HP 15-in-1 Media Card Reader	Description	Supports hardware ECC (Error Correction Code) function Supports hardware CRC (Cyclic Redundancy Check) function Supports MS 4-bit parallel transfer mode Supports MS-PRO 4-bit parallel transfer mode Supports MS PRO-HG Duo 4-bit parallel transfer mode Supports SD 4-bit parallel transfer mode Supports UHS-104 SD 4-bit card (version 3.0) Supports CF v6.0 with PIO mode 6 and Ultra DMA 7 mode	
	Interface Type	USB 3.0 High-speed inte	
	Dimensions (WxHxD)		01.6 x 25.4 mm) Fits conveniently in the 5.25"
	Supported Media Type	esCompCompactFlash Type CompactFlash Type II Microdrive Secure Digital Card (SD Secure Digital High Cap SD Extended Capacity M SD Ultra High Speed II(S Memory Stick Memory Stick Select Memory Stick Duo (MS Memory Stick PRO (MS Memory Stick PRO Duo Memory Stick PRO-HG MagicGate Memory Stick) acity (SDHC) Memory Card (SDXC) SD UHSII) Duo) S PRO) 9 (MS PRO Duo) Duo

Technical Specifications - Optical and Removable Storage

MagicGate Memory Stick Duo

		Magiobale Memory Blick Buo
		These additional media types are supported with a card adapter. Memory Stick Micro (M2) miniSD miniSD High Capacity Micro SD Memory Card (MicroSD) Micro SD High Capacity Memory Card (MicroSDHC)
		Test Parameters/Conditions - Power applied, unit operating on system ±5%
Operatin Supporte	ing Systems rted	 Windows 8 Pro (64-bit)* Windows 8.1 (64-bit)* Windows 7 Ultimate (32-bit)** Windows 7 Ultimate (64-bit)** Windows 7 Professional (32-bit)** Windows 7 Professional (64-bit)** Windows 7 Home Basic** Windows 7 Home Premium (32-bit)** Windows 7 Home Premium (64-bit)** Windows Vista Business 64 Windows Vista Business 32 Windows XP Professional Windows XP Home 32 No driver is required for this device. Native support is provided by the operating system.
		Not all features are available in all editions of Windows 8. Systems may require upgraded and/or separately purchased hardware, drivers and/or software to take full advantage of Windows 8 functionality. See http://www.microsoft.com. Not all features are available in all editions of Windows 7. This system may require upgraded and/or separately purchased hardware to take full advantage of Windows 7 functionality. See http://www.microsoft.com/windows/windows-7/ for details.
Kit Conte	ents	Media card reader, 5.25" bracket/rails/bezel, Install Guide, IO & Security Software and Documentation CD
Approval	S	USB-IF, WHQL, Compliant with USB Mass Storage Class Bulk only Transport Specification Rev. 1.0, Compliant Intel Front Panel I/O Connectivity Design Guide V. 1.3, FCC, CE, BSMI, C-Tick, VCCI, MIC, cUL, TUVT



Technical Specifications - Controller Cards

	Data Tana (an Data				
HP IEEE 1394b Data Transfer Rate FireWire PCIe Card Devices Supported		Supports up to 800 Mbps			
	Devices Supported	IEEE-1394 compliant devices			
	Bus Type	PCIe card full height PCIe slots			
	Ports	Two IEEE-1394b bilingual 9-Pin connectors (Rear)			
	Internal Connectors	One 10-Pin Header connector			
	System Requirements	Windows 7 Professional 32-bit and 64-bit, Microsoft® Windows® XP Professional, Windows XP Home, Windows Vista, SLED 11 and RHEL 6. Intel Pentium® G series or higher processor, 128-MB RAM, 1-GB Hard Drive, CD-ROM drive, built in sound system, Available PCIe slot.			
	Temperature – Operating	50° to 131° F (10° to 55° C)			
	Temperature – Storage –22° to 140° F (–30° to 60° C)				
	Relative Humidity – Operating	20% to 80%			
	Compliances	FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024- 1998 STD, Taiwan BSMI CNS13438, Korea MIC			
	Operating Systems Supported	Windows 7 Professional 32-bit and 64-bit, Windows Vista® Business 32-bit and 64-bit, Windows® XP Professional, XP Professional 64-bit, RHEL 6 and SLED 11.			
HP Thunderbolt-2 PCIe	Data Transfer Rate	Supports up to 20 Gb/s (20,000 Mb/s)			
1-port I/O Card	Devices Supported	Thunderbolt™ certified devices			
	Bus Type	PCIe card, full or half height PCIe slots			
	Ports	One Thunderbolt™ 2 external 20-Pin output connectors (Rear)			
	Internal Connectors	One 5-Pin header connector			
	System Requirements	Genuine Windows 7 Professional 64-bit, Genuine Windows 8.1 64-bit, Intel i5 series or higher processor, 128-MB RAM, 1-GB Hard Drive, available PCIe slot.			
	Temperature - Operating	50° to 131° F (10° to 55° C)			
	Temperature - Storage	e -22° to 140° F (-30° to 60° C)			
	Relative Humidity - Operating	20% to 80%			
	Compliances	FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024- 1998 STD, Taiwan BSMI CNS13438, Korea MIC			
	Operating Systems Supported	Genuine Windows 7 Professional 64-bit, Genuine Windows 8.1 64-bit.			
	Kit Contents	HP Thunderbolt [™] 2 PCIe 1-port I/O Card, full height and half height bracket, DisplayPort to DisplayPort cable, internal header cables(2), user documentation and warranty card.			
	Warranty	The HP Thunderbolt [™] 2 PCIe 1-port I/O Card has a one-year Limited Warranty or the remainder of the warranty of the HP supported product in which it is installed. Technical support is available seven days a week, 24 hours a day, by phone, as well as online support forums. Certain restrictions and exclusions apply.			

Technical Specifications - Networking and Communications

	Compostor	DI 16			
Integrated Intel 82579LM PCIe GbE	Connector Controller	RJ-45 Intel 82579LM GbE platform LAN connect networking controller			
Controller	Memory	24 KB FIFO packet buffer memory			
	Data Rates Supported				
	Compliance	802.1P, 802.1Q, 802.2, 802.3, 802.3ab, 802.3az, 802.3u			
	Bus Architecture				
	Data Transfer Mode	PCI Express and SMBus			
		PCIe-based interface for active state operation (S0 state) and SMBus for host and management traffic (Sx low power state)			
	Power Requirement	Requires 3.3V and 1.05V or just 3.3V with integrated regulators			
	Boot ROM Support	Yes			
	Network Transfer Mode Full-duplex; Half-duplex (not supported for the 1000BASE-T transceiver)				
	Network Transfer Rate	10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps			
	Management Capabilities	WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, Advanced cable diagnostic. AMT 7.0 support			
Broadcom (5761)	Connector	RJ-45			
NetXtreme Gigabit	Controller	Broadcom 5761 PCI-Express LAN Controller			
Ethernet Plus NIC	Memory	8 MB NVRAM serial Flash			
	Data Rates Supported	10/100/1000 Mbps			
	Compliance	IEEE 802.1P, 802.1Q, 802.2, 802.3, 802.3AB, 802.3u, and 802.3x			
	Bus Architecture	PCI-Express			
	Data Path Width	Single Channel PCI-Express			
	Data Transfer Mode	Bus Master DMA			
	Hardware	FCC class B, Canada and US NRTL Mark, C-Tick for Australia, BSMI			
	Certifications	for Taiwan, VCCI for Japan, MIC for Korea, GOST for Russia, UL listed (E212044), European Union Notice (CE 0682)			
	Power Requirement	1.8W @ 3.3V			
	Boot ROM Support	Yes			
	Network Transfer Mode	e Full-duplex Half-duplex (not available for the 1000BASE-T transceiver)			
	Network Transfer Rate	10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps			
	Operating Temperature32° to 131°F (0° to 55° C)				
	Operating Humidity	131° F (55° C) with 5% to 95% non-condensing humidity			
	Dimensions	7 cm x 10.5 cm (2.75 in x 4.13 in), low profile compatible			
	Operating System Driver Support	Windows 7 Professional 32-bit and 64-bit, Windows Vista 32-bit SP1, Windows Vista x64 SP1, Windows XP 32 bit professional, Windows XP x64			
		Red Hat Enterprise Linux (RHEL) 5, 6; Novell SLED 10 & 11			
	Management Capabilities	ACPI, WOL and DMI 2.0, PXE 2.0, WfM 2.0, Broadcom mgmt utility, ASF2.0, DASH 1.0 and DASH 1.1 profiles			



Technical Specifications - Networking and Communications

	Kit Contents	Broadcom NetXtreme Gigabit Ethernet Plus NIC, Broadcom NetXtreme Gigabit Ethernet Plus NIC USB Cable Assembly, CD, drivers, quick install guide, product warranty statement			
Intel Gigabit CT	Connector	RJ-45			
Desktop NIC	Controller	Intel WG82574L Gigabit Ethernet Controller			
	Memory	Integrated Dual 48K configurable transmit receive FIFO Buffers			
	Data Rates Supported	10/100/1000 Mbps			
	Compliance	IEEE 802.1P, 802,1Q, 802.2, 802.3, 802.3AB and 802.3u compliant, 802.3x flow control			
	Bus Architecture	PCI-E 1.0a			
	Data Path Width	X1, 250 MB/s, Bi-directional interface			
	Data Transfer Mode	Bus-master DMA			
	Hardware Certifications	FCC, B, CE, TUV- cTUVus Mark Canada and United States, TUV- GS Mark for European Union			
	Power Requirement	Aux 3.3V, 3.0 Watts in 1000base-T and 2.0 Watts in 100Base-T			
	Boot ROM Support	Yes			
	Network Transfer Rate	10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps			
	Operating Temperature32° to 131°F (0° to 55° C)				
	Operating Humidity	85% at 131° F (55° C)			
	Dimensions	12.1 x 5.7 x 2.0 cm (4.75 x 2.25 x 0.8 in)			
	Operating System Driver Support	Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64, Windows Vista Business 32, Windows XP Professional, Windows XP x64. Red Hat Enterprise Linux 4 (RHEL4.8 or newer)*, Red Hat Enterprise Linux 5 (RHEL5.3 or newer), Red Hat Enterprise Linux 6, SUSE Linux Enterprise Desktop (SLED) 11			
		PHEL 4 and 5 SLED 10, are not supported on the 7220 CMT/SEE			
	Management Capabilities	RHEL 4 and 5, SLED 10, are not supported on the Z220 CMT/SFF WOL , PXE, DMI, WFM 2.0			
	Kit Contents	Intel Gigabit CT Desktop NIC, low profile bracket, CD containing Intel PROset II NIC drivers, quick install guide, product warranty statement			
HP X520 10GbE Dual Port Adapter	Hardware Certifications	FCC B, UL, CE, VCCI, BSMI, CTICK, KCC			
HP 10GbE SFP+ SR Transceiver	Operating Humidity	e0°C to 45°C (32°F to 113°F) 0% to 85%, noncondensing) 0.47(h) x 0.54(w) x 2.19(d)inches (1.19 x 1.38 x 5.57 cm)			



Technical Specifications - Networking and Communications

HP 361T PCIe Dual PortConnector Gigabit NIC Controller Data Rates Supported Compliance		Two RJ-45 Intel® Ethernet I350 Controller 10/100/1000 Mbps, Half- and full-duplex 802.3, 802.3u, 802.3x, 802.3ab, 802.3ad, 802.1p, 802.1Q, 802.3az, IEEE 1588 PCIe v2.0 standard RoHS (6 of 6)
		FCC (U.S. only) Class B DOC (Canada) Class B CE EN 55024, EN55022 Class B VCCI Class II UL 1950 CSA 950 EN 60950 CE ACPI 1.1a Microsoft WHQL (Windows Hardware Quality Labs)
	Bus Architecture	PCI-E 1.0a
	Data Path Width	Four lane (x4) PCI Express compatible with x4, x8, and x16 PCI Express slots
	Power Requirement	4.1W idle without EEE link partner 3.2W idle with EEE link partner 4.2W maximum
	Network Transfer Rate	10BASE-T (half-duplex) 10 Mb/s 10BASE-T (full-duplex) 20 Mb/s 100BASE-TX (half-duplex) 100 Mb/s 100BASE-TX (full-duplex) 200 Mb/s 1000BASE-T (full-duplex) 2000 Mb/s
Operating Temperatur		e 32° to 131°F (0° to 55° C)
	Operating Humidity	10% to 95% non-condensing
) 5.3 x 2.5 in (13.50 cm x 6.4 cm) (without brackets)
	Operating System Driver Support	Windows 7 Professional 32-bit and 64-bit. Red Hat Enterprise Linux(RHEL) WS4, 5, 6 Desktop/Workstation Novell SLED 10 & SLED 11
	Management Capabilities	WOL , PXE 2.1
	Kit Contents	HP 361T PCIe Dual Port Gigabit NIC PCA with a standard height bracket attached to it (the low profile bracket is included in the clamshell that the PCA ships in) Product Warranty statement and the Quick Install Card (QIC).

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